INCH POUND

MIL-M-38510/15B 14 April 2005 SUPERSEDING MIL-M-38510/15A 27 July 1979

MILITARY SPECIFICATION

MICROCIRCUITS, DIGITAL, TTL, BISTABLE LATCHES, MONOLITHIC SILICON

Inactive for new design after 6 September 1996.

This specification is approved for use by all Departments and Agencies of the Department of Defense.

The requirements for acquiring the product herein shall consist of this specification sheet and MIL-PRF 38535

1. SCOPE

1.1 <u>Scope.</u> This specification covers the detail requirements for monolithic, silicon, TTL, 4-bit bistable latch microcircuits. Two product assurance classes and a choice of case outlines and lead finishes are provided for each type and are reflected in the complete part number. For this product, the requirements of MIL-M-38510 have been superseded by MIL-PRF-38535, (see 6.4).

- 1.2 Part or Identifying Number (PIN). The PIN is in accordance with MIL-PRF-38535, and as specified herein.
- 1.2.1 <u>Device types.</u> The device types are as follows:

Device type	Circuit
01 02	4-bit latch, complementary outputs 4-bit latch
02	Dual 4-bit latch
04	4-bit latch, master reset

1.2.2 <u>Device class</u>. The device class is the product assurance level as defined in MIL-PRF-38535.

1.2.3 Case outlines. The case outlines are as designated in MIL-STD-1835 and as follows:

Outline letter	Descriptive designator	Terminals	Package style
А	GDFP5-F14 or CDFP6-F14	14	Flat pack
В	GDFP4-F14	14	Flat pack
С	GDIP1-T14 or CDIP2-T14	14	Dual-in-line
D	GDFP1-F14 or CDFP2-F14	14	Flat pack
E	GDIP1-T16 or CDIP2-T16	16	Dual-in-line
F	GDFP2-F16 or CDFP3-F16	16	Flat-pack
J	GDIP1-T24 or CDIP2-T24	24	Dual-in-line
K	GDFP2-F24 or CDFP3-F24	24	Flat-pack
L	GDIP3-T24 or CDIP4-T24	24	Dual-in-line
Z	GDFP7-F24 or CDFP8-F24	24	Flat-pack

Comments, suggestions, or questions on this document should be addressed to: Commander, Defense Supply Center Columbus, ATTN: DSCC-VAS, P. O. Box 3990, Columbus, OH 43218-3990, or emailed to bipolar@dscc.dla.mil. Since contact information can change, you may want to verify the currency of this address information using the ASSIST Online database at http://assist.daps.dla.mil.

1.3 Absolute maximum ratings.

Supply voltage range Input voltage range Storage temperature range	1.5 V dc at -12 mA to +5.5 V dc
Maximum power dissipation per gate, (P _D) <u>1</u> /	
Device types 01 and 02	. 280 mW dc
Device type 03	. 630 mW dc
Device type 04	. 325 mW dc
Lead temperature (soldering 10 seconds)	. 300°C
Thermal resistance, junction-to-case (θ_{JC})	(See MIL-STD-1835)
Junction temperature (T _J) <u>2</u> /	. 175°C

1.4 Recommended operating conditions.

Supply voltage	4.5 V dc minimum to 5.5 V dc maximum
Minimum high level input voltage	2.0 V dc
Maximum low level input voltage	
Normalized fanout (each output) 3/	
Case operating temperature range (T _c)	-55°C to 125°C
Setup time, t(SETUP) data to output	
Types 01 and 02	25 ns minimum
Setup time t(SETUP), type 03	
Data to enable (high)	
Data to enable (low)	16 ns minimum
Setup time t(_{SETUP}), type 04	
Data to enable (high)	
Data to enable (low)	25 ns minimum
Setup time, t(SETUP) data to set (high)	
Туре 04	8 ns minimum
Input hold time $t(_{HOLD})$, types 01 and 02	-
Clock to data	
Data to clock	30 ns minimum
Input hold time $t_{(HOLD)}$, type 03	
Data to enable (high)	
Data to enable (low) Input hold time t(_{HOLD}), type 04	4 115 1110311110111
Data to enable (high)	
Data to enable (low)	
Input hold time $t_{(HOLD)}$, type 04	
Data to set (low)	8 ns maximum

2.0 APPLICABLE DOCUMENT

2.1 <u>General.</u> The documents listed in this section are specified in sections 3, 4, or 5 of this specification. This section does not include documents cited in other sections of this specification or recommended for additional information or as examples. While every effort has been made to ensure the completeness of this list, document users are cautioned that they must meet all specified requirements of documents cited in sections 3, 4, or 5 of this specification, whether or not they are listed.

 $[\]underline{1}$ Must withstand the added P_D due to short circuit condition (e.g. I_{OS}) at one output for 5 seconds duration.

^{2/} Maximum junction temperature should not be exceeded except in accordance with allowable short duration burn-in screening condition in accordance with MIL-PRF-38535.

^{3/} Device will fanout in both high and low levels to the specified number of inputs of the same device type as that being tested.

2.2 Government documents.

2.2.1 <u>Specifications and standards.</u> The following specifications and standards form a part of this specification to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

DEPARTMENT OF DEFENSE SPECIFICATIONS

MIL-PRF-38535 - Integrated Circuits (Microcircuits) Manufacturing, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883	-	Test Method Standard for Microelectronics.
MIL-STD-1835	-	Interface Standard Electronic Component Case Outlines

(Copies of these documents are available online at http://assist.daps.dla.mil/quicksearch/ or http://assist.daps.dla.mil or from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.3 <u>Order of precedence.</u> In the event of a conflict between the text of this specification and the references cited herein, the text of this document takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 <u>Qualification</u>. Microcircuits furnished under this specification shall be products that are manufactured by a manufacturer authorized by the qualifying activity for listing on the applicable qualified manufacturers list before contract award (see 4.3 and 6.3).

3.2 <u>Item requirements</u>. The individual item requirements shall be in accordance with MIL-PRF-38535 and as specified herein or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein.

3.3 <u>Design, construction, and physical dimensions.</u> The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535 and herein.

3.3.1 <u>Terminal connections</u>. The terminal connections shall be as specified on figure 1.

3.3.2 Truth tables and logic equations. The truth tables and logic equations shall be as specified on figure 2.

3.3.3 Logic diagrams. The logic diagrams shall be as specified on figure 3.

3.3.4 <u>Schematic circuit</u>. The schematic circuit shall be maintained by the manufacturer and made available to the qualifying activity and the preparing activity upon request.

3.3.5 Case outlines. Case outlines shall be as specified in 1.2.3.

3.4 Lead material and finish. Lead material and finish shall be in accordance with MIL-PRF-38535 (see 6.6).

3.5 <u>Electrical performance characteristics</u>. The electrical performance characteristics are as specified in table 1 and apply over the full recommended case operating temperature range, unless otherwise specified.

3.6 <u>Electrical test requirements.</u> The electrical test requirements for each device class shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table III.

3.7 Marking. Marking shall be in accordance with MIL-PRF-38535.

3.8 <u>Microcircuit group assignment.</u> The devices covered by this specification shall be in microcircuit group number 5 (see MIL-PRF-38535, appendix A).

Test	Symbol	Device	Lir	nits	Unit	
		$-55^{\circ}C \leq T_{C} \leq +125^{\circ}C$	types	Min	Max	
		unless otherwise specified				
High level output voltage	V _{OH}	V _{CC} = 4.5V; I _{OH} = -400μA	01, 02	2.4		V
		$V_{IN} = 0.8V$ $I_{OH} = -800\mu A$	03, 04	2.4		V
Low level output voltage	V _{OL}	$V_{CC} = 4.5V; I_{OL} = 16 \text{ mA}$	01,02,04		0.4	V
		V _{IN} = 2.0V I _{OL} = 14.4 mA	03		0.4	V
Input clamp voltage	V _{IC}	V _{CC} = 4.5 V; V _{IN} = -12 mA	All		-1.5	V
Low level input current, data	I _{IL1}	V _{CC} = 5.5 V; V _{IN} = 0.4 V	01, 02	-1.4	-3.2	mA
			03 <u>4</u> /	-0.5	-2.4	mA
			04	-0.7	-2.7	mA
Low level input current Clock	I _{IL2}	$V_{CC} = 5.5 \text{ V}; V_{IN} = 0.4 \text{ V} \underline{1}/$	01, 02	-2.8	-6.4	mA
Master reset and enable			03, 04	-0.7	-1.6	mA
Set			04	-0.7	-1.6	mA
High level input current, data	I _{IH1}	V _{CC} = 5.5 V; V _{IN} = 2.4 V <u>1</u> /	01, 02		80	μA
			03		40	μA
			04		60	μA
High level input current, data	I _{IH2}	V _{CC} = 5.5 V; V _{IN} = 5.5 V <u>1</u> /	01, 02		200	μA
			03, 04		100	μA
High level input current Clock	I _{IH3}	V _{CC} = 5.5 V; V _{IN} = 2.4 V <u>1</u> /	01, 02		160	μA
Master reset and enable			03, 04		40	μA
Set			04		40	μA
High level input current	I _{IH4}	V _{CC} = 5.5 V; V _{IN} = 5.5 V 1/				
Clock			01, 02		400	μA
Master reset and enable			03, 04		100	μA
Set			04		100	μA
Short circuit output current	los	$V_{\rm CC} = 5.5 \ V \ \underline{2} / \ \underline{3} /$	01, 02	-20	-57	mA
			03 <u>5</u> /	-10	-70	mA
			04	-20	-100	mA
Supply current	I _{CC}	V _{CC} = 5.5 V <u>2</u> /;	01, 02		46	mA
		V _{IN} = 4.5 V	03		106	mA
			04		55	mA
	Propagatior	delay time for types 01 and 02				
To high level, from D input to Q output	t _{PLH1}	C _L = 50 pF ± 10%; R _L = 390 ohms ± 5%	01, 02	2	44	ns
To high level, from D input to \overline{Q} output	t _{PLH2}		01	2	55	ns
To low level, from D input to Q output	t _{PHL1}		01, 02	2	38	ns
To low level, from D input to \overline{Q} output	t _{PHL2}		01	2	25	ns
To low level, from clock input to Q output	t _{PHL3}		01	2	25	ns

TABLE I. Electrical performance characteristics.

See footnotes at end of table.

Test	Symbol	Conditions	Device	Lin	nits	Unit
		$-55^{\circ}C \le T_C \le +125^{\circ}C$	types	Min	Max	
		unless otherwise specified				
To high level, from clock input to Q output	t _{PLH3}	C _L = 50 pF ± 10%; R _L = 390 ohms ± 5%	01, 02	2	44	ns
To low level, from clock input to \overline{Q} output	t _{PHL4}		01	2	25	ns
To high level from clock input to \overline{Q} output	t _{PLH4}		01	2	44	ns
I	Propagatio	n delay time for types 03 and (04			
To high level, from enable to	t _{PLH1}	C_{L} = 50 pF ± 10%;	03, 04	3	60	ns
output		R_L = 390 ohms \pm 5%				
To low level, from enable to output	t _{PHL1}		03, 04	3	40	ns
To high level, from data to	t _{PLH2}		03, 04	3	49	ns
output						
To low level, from data to	t _{PHL2}		03, 04	3	37	ns
output						
To low level, from master reset	t _{PHL3}		03, 04	3	37	ns
to output		_				
To high level, from set to	t _{PLH4}		04	9	47	ns
output						

TABLE I. Electrical performance characteristics - Continued

<u>1/</u> <u>2/</u> <u>3/</u> <u>4/</u> 5/

All unspecified inputs at 5.5 V. All unspecified inputs grounded. Not more than one output should be shorted at a time.

Circuit B limits for I_{IL1} shall be -1.6 mA, maximum. Circuit B and C limits for I_{OS} shall be -20 mA minimum to -57 mA maximum.

	Subgroups (see table III)		
MIL-PRF-38535 Test requirement	Class S Devices	Class B Devices	
Interim electrical parameters	1	1	
Final electrical test parameters	1*, 2, 3, 9, 10, 11	1*, 2, 3, 9	
Group A test requirements	1, 2, 3, 9, 10, 11	1, 2, 3, 9,	
Group B electrical test parameters when using the method 5005 QCI option	1, 2, 3	N/A	
Groups C end point electrical parameters	1, 2, 3	1, 2, 3	
Additional electrical subgroups for Group C periodic inspections	N/A	10, 11	
Group D end point electrical parameters	1, 2, 3	1, 2, 3	

TABLE II. Electrical test requirements.

*PDA applies to subgroup 1.

4. VERIFICATION

4.1 <u>Sampling and inspection</u>. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not effect the form, fit, or function as described herein.

4.2 <u>Qualification inspection</u>. Qualification inspection shall be in accordance with MIL-PRF-38535.

4.3 <u>Screening</u>. Screening shall be in accordance with MIL-PRF-38535 and shall be conducted on all devices prior to qualification and conformance inspection. The following additional criteria shall apply:

- a. The burn-in test duration, test condition, and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document control by the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.
- b. Interim and final electrical test parameters shall be as specified in table II, except interim electrical parameters test prior to burn-in is optional at the discretion of the manufacturer.
- c. Additional screening for space level product shall be as specified in MIL-PRF-38535.

4.4 <u>Technology Conformance Inspection (TCI)</u>. Technology conformance inspection shall be in accordance with MIL-PRF-38535 and herein for groups A, B, C, and D inspections (see 4.4.1 through 4.4.4).

4.4.1 <u>Group A inspection</u>. Group A inspection shall be in accordance with table III of MIL-PRF-38535 and as follows:

a. Tests shall be as specified in table II herein.

b. Subgroups 4, 5, 6, 7, and 8 shall be omitted.

4.4.2 Group B inspection. Group B inspection shall be in accordance with table II of MIL-PRF-38535.

4.4.3 <u>Group C inspection</u>. Group C inspection shall be in accordance with table IV of MIL-PRF-38535 and as follows:

- a. End point electrical parameters shall be as specified in table II herein.
- b. Subgroups 3 and 4 shall be added to the group C inspection requirements for class B devices and shall consist of the tests, conditions, and limits specified for subgroups 10 and 11 of group A.
- c. The steady-state life test duration, test condition, and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document control by the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.

4.4.4 <u>Group D inspection</u>. Group D inspection shall be in accordance with table V of MIL-PRF-38535. End-point electrical parameters shall be as specified in table II herein.

4.5 <u>Methods of inspection</u>. Methods of inspection shall be as specified in the appropriate tables and as follows:

4.5.1 <u>Voltage and current</u>. All voltages given are referenced to the microcircuit ground terminal. Currents given are conventional current and positive when flowing into the referenced terminal.

	Device type 01	Device type 02 03		Device type 04
Terminal	Cases	Cases	Cases	Cases
number	E and F	A, B, C and D	J, K, L and Z	E and F
1	1 Q	1D	MR	Ē
2	1D	2D	ĒO	<u>s</u> 0
3	2D	CLOCK 3-4	Ē1	D0
4	CLOCK 3-4	Vcc	D0	D1
5	Vcc	3D	Q0	<u></u> S 2
6	3D	4D	D1	D2
7	4D	NC	Q1	D3
8	4 Q	4Q	D2	GND
9	4Q	3Q	Q2	MR
10	3Q	NC	D3	Q3
11	3 Q	GND	Q3	<u></u> S 3
12	GND	CLOCK 1-2	GND	Q2
13	CLOCK 1-2	2Q	MR	Q1
14	2 Q	1Q	ĒO	<u></u>
15	2Q		Ē1	Q0
16	1Q		D0	Vcc
17			Q0	
18			D1	
19			Q1	
20			D2	
21			Q2	
22			D3	
23			Q3	
24			Vcc	

Figure 1. <u>Terminal connections.</u>

Device types 01 and 02

Truth table					
tn tn+1					
D	Q				
Н	Н				
L	L				

NOTES:

1. tn = bit time before clock negative-going transition.

2. tn+1 = bit time after clock negative-going transition.

Device type 03

	Truth table							
MR	Ē0	Ē1	D	Qn	Operation			
Н	L	L	L	L	Data entry			
Н	L	L	Н	Н	Data entry			
Н	L	Н	Х	Qn-1	Hold			
Н	Н	L	Х	Qn-1	Hold			
Н	Н	Н	Х	Qn-1	Hold			
L	Х	Х	Х	L	reset			

X = Don't care

L = Low voltage level

H = High voltage level Qn-1 = Previous output state

Qn = Present output state

Device type 04

	Truth table							
MR	Ē	D	s	Qn	Operation			
Н	L	L	L	L	D mode			
Н	L	Н	L	Н				
Н	Н	Х	Х	Qn-1				
Н	L	L	L	L	R/S mode			
Н	L	Н	L	Н				
Н	L	L	Н	L				
Н	L	Н	Н	Qn-1				
Н	Н	Х	Х	Qn-1				
L	Х	Х	Х	L	Reset			

X = Don't care

L = Low voltage level

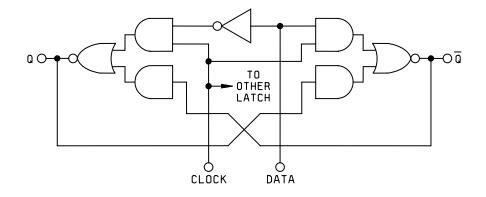
H = High voltage level

Qn-1 = Previous output state

Qn = Present output state

Figure 2. Truth tables.

Device type 01



Device type 02

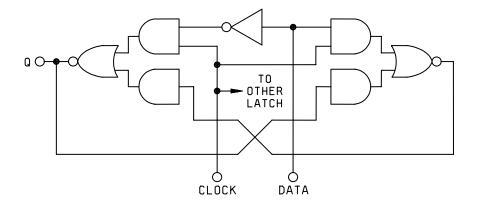


Figure 3. Logic diagrams.

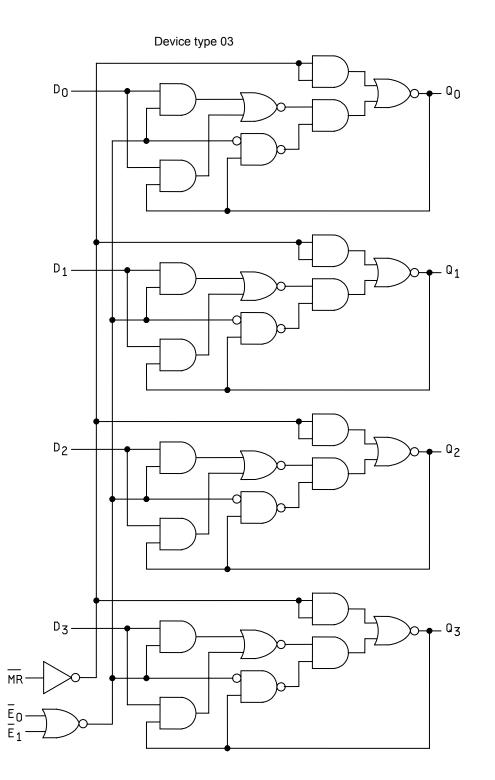


Figure 3. Logic diagrams – Continued.

Device type 04

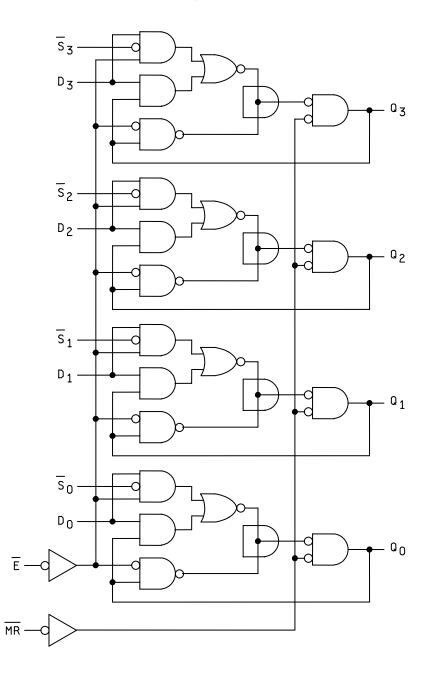
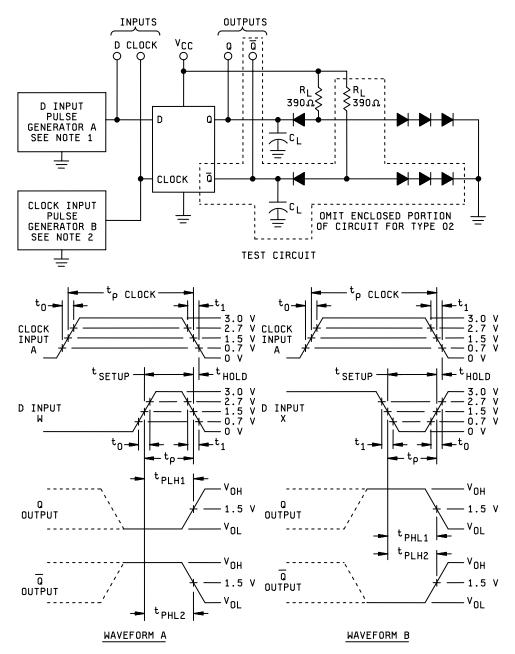


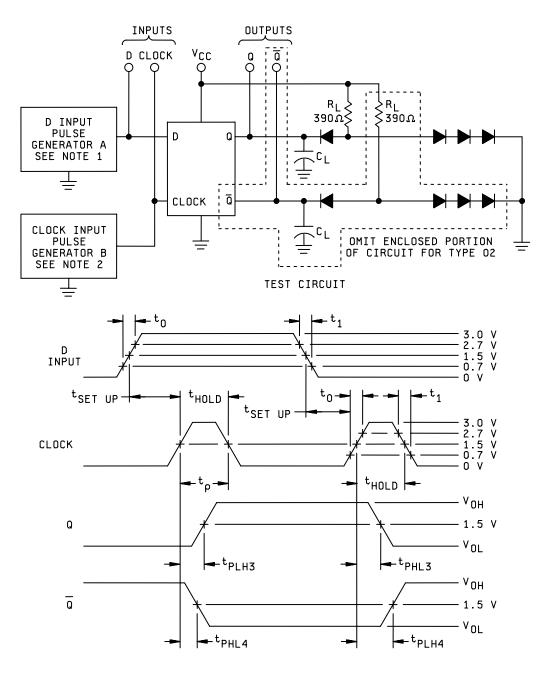
Figure 3. Logic diagrams – Continued.



NOTES:

- 1. The D input pulse generator has the following characteristics: V_{GEN} = 3 V, t_1 = $t_0 \le 10$ ns, t_P = 30 ns, $t_{(SETUP)}$ = 25 ns, $t_{(HOLD)}$ = 5 ns, PRR = 1 MHz and $Z_{OUT} \approx 50 \Omega$.
- 2. The clock pulse generator has the following characteristics: V_{GEN} = 3 V minimum, t_1 = $t_0 \le 10$ ns, $t_{P(CLOCK)}$ = 500 ns, and PRR = 1 MHz.
- 3. Prior to testing the device shall be precondition to a high logic level for waveform A and to a low logic level for waveform B.
- 4. Each latch is tested separately.
- 5. $C_L = 50 \text{ pF}$, which includes probe and jig capacitance.
- 6. R_L = 390 $\Omega \pm 5\%$.
- 7. The Q waveforms are not applicable to type 02.
- 8. All diodes are 1N3064 or equivalent.

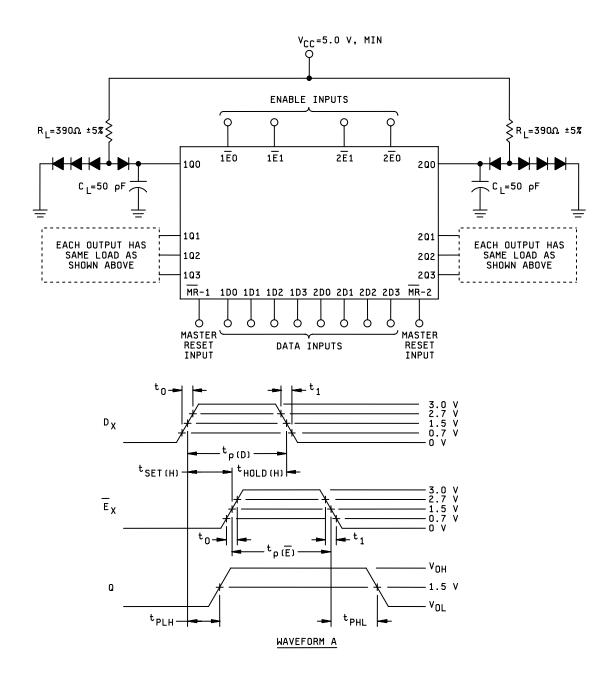
Figure 4. Switching test circuit and data to output waveforms for device types 01 and 02.



NOTES:

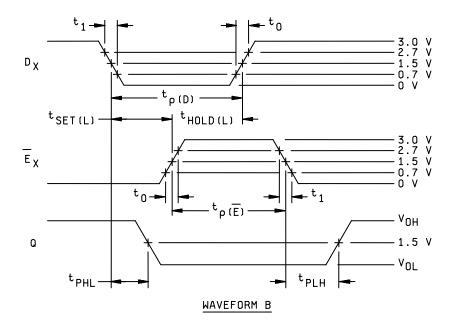
- 1. The D input pulse generator has the following characteristics: V_{GEN} = 3 V, t_1 = $t_0 \le 10$ ns, PRR = 500 kHz at 50 % duty cycle. For subgroups 7 and 8, PRR ≤ 25 kHz at 50 % cuty cycle and PRR (D input) = 1/2 PRR (clock).
- 2. The clock pulse generator has the following characteristics: V_{GEN} = 3 V minimum, t_1 = $t_0 \le 10$ ns, $t_{(HOLD)}$ = $t_{P(CLOCK)}$ = 30 ns, $t_{(SETUP)}$ = 25 ns and PRR = 1 MHz. For subgroups 7 and 8, PRR ≤ 50 kHz.
- 3. Each latch is tested separately.
- 4. $C_L = 50 \text{ pF}$, which includes probe and jig capacitance.
- 5. R_L = 390 $\Omega \pm 5\%$.
- 6. The Q waveforms are not applicable to device type 02.
- 7. All diodes are 1N3064 or equivalent.

Figure 5. Switching test circuit and clock to output waveforms for device types 01 and 02.



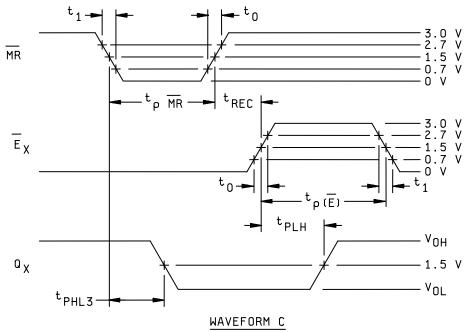
NOTES:

- 1. The data inputs have the following characteristics: $V_{GEN} = 3 V$, $t_1 = t_0 \le 10 ns$, $t_{P(D)} = 10 ns$, PRR = 1 MHz.
- 2. The enable inputs have the following characteristics: V_{GEN} = 3 V, t_1 = $t_0 \le 10$ ns, $t_{SET(H)}$ = 10 ns, $t_{HOLD(H)}$ = 0 ns, $t_{P(E)}$ = 20 ns, PRR = 1 MHz and $Z_{OUT} \approx 50\Omega$.
- 3. Each latch is tested separately.
- 4. $C_L = 50 \text{ pF}$, which includes probe and jig capacitance.
- 5. $R_L = 390 \Omega \pm 5\%$.
- 6. All diodes are 1N3064 or equivalent.



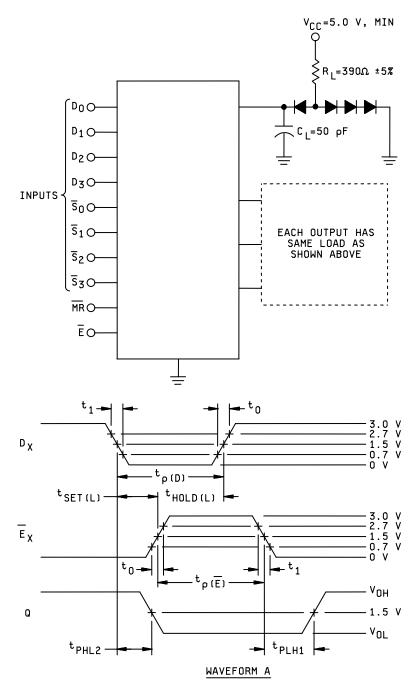
NOTES:

- 1. The master reset inputs have the following characteristics: V_{GEN} = 3 V, t_0 = $t_1 \le 10$ ns, $t_{P(D)}$ = 26 ns and PRR = 1 MHz.
- 2. The enable inputs have the following characteristics: V_{GEN} = 3 V, t_1 = $t_0 \le 10$ ns, $t_{SET(L)}$ = 16 ns, $t_{HOLD(L)}$ = 10 ns, $t_{P(\overline{E})}$ = 20 ns, PRR = 1 MHz and $Z_{OUT} \approx 50\Omega$.



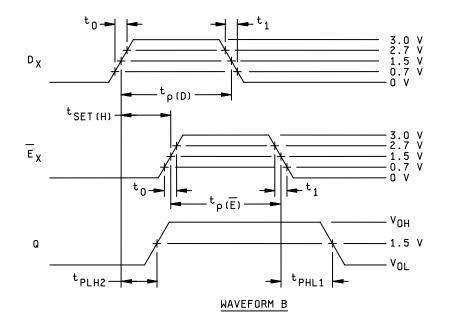
NOTES:

- 1. The master reset inputs have the following characteristics: V_{GEN} = 3 V, t_0 = $t_1 \le 10$ ns, $t_{P(\overline{MR})}$ = 20 ns and PRR = 1 MHz.
- 2. The enable inputs have the following characteristics: V_{GEN} = 3 V, t_1 = $t_0 \le 10$ ns, t_{REC} = 10 ns, $t_{P(\bar{E})}$ = 20 ns, PRR = 1 MHz and $Z_{OUT} \approx 50\Omega$.



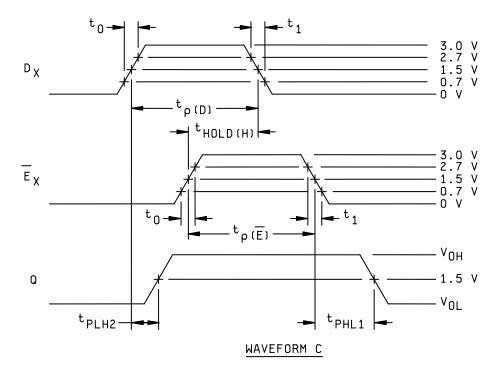
NOTES:

- 1. The data inputs have the following characteristics: V_{GEN} = 3 V, t_1 = $t_0 \le 10$ ns, $t_{P(D)}$ = 32 ns, PRR = 1 MHz.
- The enable input has the following characteristics: $V_{GEN} = 3 V$, $t_1 = t_0 \le 10 ns$, $t_{P(E)} = 20 ns$, $t_{SET(L)} = 25 ns$, 2. $t_{HOLD(L)} = 7 \text{ ns}, \text{ PRR} = 1 \text{ MHz and } Z_{OUT} \approx 50 \Omega$.
- 3. Each latch is tested separately.
- 4. C_L = 50 pF, which includes probe and jig capacitance.
- 5. $R_L = 390 \Omega \pm 5\%$.
- All diodes are 1N3064 or equivalent. 6.



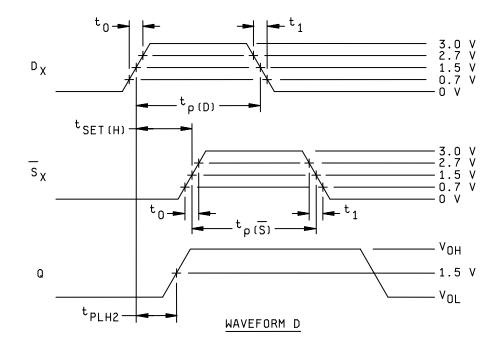
NOTES:

- 1. The data inputs have the following characteristics: V_{GEN} = 3 V, t_0 = $t_1 \le 10$ ns, $t_{P(D)}$ = 20 ns and PRR = 1 MHz.
- The enable input has the following characteristics: $V_{GEN} = 3 V$, $t_1 = t_0 \le 10 \text{ ns}$, $t_{P(\overline{E})} = 20 \text{ ns}$, $t_{SET(H)} = 5 \text{ ns}$, 2. PRR = 1 MHz and $Z_{OUT} \approx 50\Omega$.



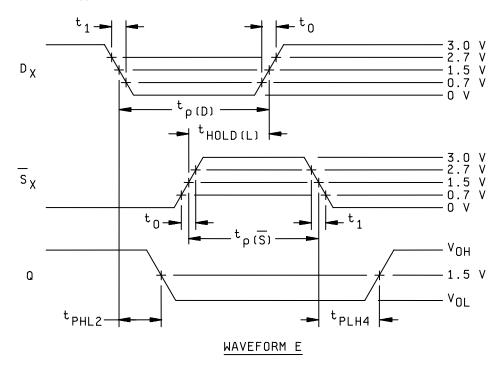
NOTES:

- 1.
- The data inputs have the following characteristics: V_{GEN} = 3 V, t_0 = $t_1 \le 10$ ns, $t_{P(D)}$ = 20 ns and PRR = 1 MHz. The enable inputs have the following characteristics: V_{GEN} = 3 V, t_1 = $t_0 \le 10$ ns, $t_{P(\bar{E})}$ = 20 ns, $t_{HOLD(H)}$ = 0 ns, 2. PRR = 1 MHz and $Z_{OUT} ≈ 50Ω$.



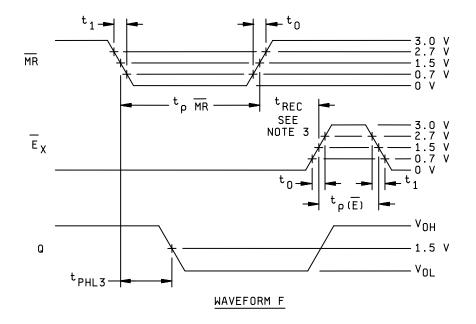
NOTES:

- 1. The data inputs have the following characteristics: $V_{GEN} = 3 V$, $t_0 = t_1 \le 10 ns$, $t_{P(D)} = 20 ns$ and PRR = 1 MHz.
- 2. The set inputs have the following characteristics: $V_{GEN} = 3 \text{ V}$, $t_1 = t_0 \le 10 \text{ ns}$, $t_{P(\overline{S})} = 20 \text{ ns}$, $t_{SET(H)} = 8 \text{ ns}$, PRR = 1 MHz and $Z_{OUT} \approx 50\Omega$.



NOTES:

- 1. The data inputs have the following characteristics: V_{GEN} = 3 V, t_0 = $t_1 \le 10$ ns, $t_{P(D)}$ = 20 ns and PRR = 1 MHz.
- 2. The set inputs have the following characteristics: $V_{GEN} = 3 \text{ V}$, $t_1 = t_0 \le 10 \text{ ns}$, $t_{P(\overline{S})} = 20 \text{ ns}$, $t_{HOLD(L)} = 8 \text{ ns}$, PRR = 1 MHz and $Z_{OUT} \approx 50\Omega$.



NOTES:

- 1. The master reset input has the following characteristics: V_{GEN} = 3 V, t_0 = $t_1 \le 10$ ns, $t_{P(MR)}$ = 18 ns and PRR = 1 MHz.
- The enable inputs have the following characteristics: V_{GEN} = 3 V, t_1 = $t_0 \le 10$ ns, $t_{P(\overline{E})}$ = 20 ns, t_{REC} = 0 ns, 2.
- PRR = 1 MHz and $Z_{OUT} \approx 50\Omega$. Recovery time is the minimum time that enable must remain low after the master reset transition from low to 3. high in order for the latch to recognize and store high data.

		MIL-	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16			Test limits	i
Subgroup	Symbol	STD-883 method	Test No.	1 Q	1D	2D	CLOCK 3-4	Vcc	3D	4D	4 Q	4Q	3Q	3 Q	GND	CLOCK 1-2	2 Q	2Q	1Q	Meas. terminal	Min	Max	Unit
1	V _{OH}	3006	1	-0.4 mA	0.8 V			4.5 V							GND	2.0 V				1 Q	2.4		V
T _C = 25°C	"	"	2		2.0 V														-0.4 mA	1Q			"
	"	"	3			0.8 V											-0.4 mA			2 Q			"
	"	"	4			2.0 V												-0.4 mA		2Q			"
	"	"	5				2.0 V		0.8 V					-0.4 mA						3 Q			"
			6						2.0 V				-0.4 mA							3Q			"
	"	"	7							0.8 V	-0.4 mA									4 Q			"
	"	"	8							2.0 V		-0.4 mA								4Q			"
	V _{OL}	3007	9	16 mA	2.0 V			"								2.0 V				1 Q		0.4	"
			10		0.8 V														16 mA	1Q			"
			11			2.0 V											16 mA			2 Q			"
	"		12			0.8 V										"		16 mA		2Q			"
	"		13				2.0 V		2.0 V					16 mA						3 Q			"
	"		14						0.8 V				16 mA							3Q			"
			15							2.0 V	16 mA									4 Q			
	"		16							0.8 V		16 mA								4Q			**
	I _{IL1}	3009	17		0.4 V			5.5 V								4.5 V				1D	-1.4	-3.2	mA
	"	•	18			0.4 V										4.5 V				2D			"
	"	•	19				4.5 V		0.4 V											3D			"
			20				4.5 V	"		0.4 V										4D	•		
	I _{IL2}	"	21		0.8 V	0.8 V		"								0.4 V				CLK 1-2	-2.8	-6.4	66
	I _{IL2}	"	22				0.4 V	"	0.8 V	0.8 V					"					CLK 3-4	-2.8	-6.4	"
	I _{IH1}	3010	23		2.4 V											GND				1D		80	μA
	"	"	24			2.4 V		"							"	GND				2D		"	"
		"	25				GND	"	2.4 V											3D			"
	ű	"	26				GND	"		2.4 V					"					4D			"
	I _{IH2}	"	27		5.5 V			"							"	GND				1D		200	"
	**	"	28			5.5 V		"							"	GND				2D		"	"
	"		29				GND		5.5 V											3D		"	"
		"	30				GND	"		5.5 V					"					4D		"	
	I _{IH3}	"	31		GND	GND		"								2.4 V				CLK 1-2		160	"
	I _{IH3}	"	32				2.4 V		GND	GND										CLK 3-4		160	"
	I _{IH4}	"	33		GND	GND			0.10	0.115						5.5 V				CLK 1-2		400	"
	I _{IH4}	"	34				5.5 V		GND	GND										CLK 3-4		400	

TABLE III. Group A inspection for device type 01. Terminal conditions (pins not designated may be H \geq 2.0 V or L \leq 0.8 V or open).

See footnotes at end of device type 01.

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		MIL-	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16			Test limits	
Subgroup	Symbol	STD-883 method	Test No.	1 Q	1D	2D	CLOCK 3-4	Vcc	3D	4D	4 Q	4Q	3Q	3 Q	GND	CLOCK 1-2	2 Q	2Q	1Q	Meas. terminal	Min	Max	Unit
1	I _{os}	3011	35	GND	GND	20		55 V	00	40		τα	- OQ		GND	4.5 V		20	iQ	1 Q	-20	-57	mA
T _C = 25°C	"	"	36		4.5 V														GND	1Q			"
0	"	"	37			GND											GND			2 Q			"
	"	"	38			4.5 V												GND		2Q			**
	"	"	39				4.5 V		GND					GND						3 Q			"
			40						4.5 V				GND							3Q			"
	u	"	41							GND	GND									4 Q			"
	"	"	42							4.5 V		GND								4Q			**
	Icc	3005	43		GND	GND	GND	"	GND	GND						GND				V _{CC}		46	"
	VIC		44		-12 mA			4.5 V												1D		-1.5	V
			45													-12 mA				CLK 1-2			"
	u		46			-12 mA														2D			**
	"		47						-12 mA											3D			"
	"		48				-12 mA													CLK 3-4			"
			49							-12 mA										4D			
2	Same tests,	terminal conc	litions and limits a	as for sub	group 1, ex	kcept T _C =	125°C and	d V _{IC} tests	are omitte	ed.													
3	Same tests,	terminal conc	litions and limits a	as for subo	group 1, e	kcept T _C =	-55°C and	V_{IC} tests	are omitte	d.													
7 <u>1</u> /	Truth	3014	50		В	В	В	5.0 V	В	В					GND	В							
T _C = 25°C	table		51		В	В	А		В	В						А							
	test		52		А	А	А		А	А						А							
	u		53	L	А	Α	В		А	А	L	н	н	L		В	L	н	н				
		•	54		А	Α	В		А	А						В					<u>2</u> /		
		"	55		А	А	А		А	А						А							
	"	"	56		В	В	A		В	В						Α							
		"	57	н	В	В	В		В	В	н	L	L	н		В	Н	L	L				
	"	"	58		В	В	В		В	В						В							
			59		A	A	В	"	A	A					"	В							
	u	"	60		A	A	A	"	A	A					"	A							
	"	"	61	L	A	A	В	"	A	A	L	Н	н	L		В	L	н	Н				
			62		A	A	В		A	A					.	В							
	"	"	63		В	В	В		В	В					.	В							
			64		В	В	A		В	В						A							
0.4/.0/		<u> </u>	65	H	В	B	A		В	В	Н	L	L	Н		A	Н	L	L				
8 <u>1</u> / <u>3</u> /	Same tests,	terminal cond	litions and limits a	as for subg	group 1, ex	kcept I _C =	125°C and	$1 I_{\rm C} = -55$	°С.														

TABLE III. Group A inspection for device type 01. Terminal conditions (pins not designated may be H \geq 2.0 V or L \leq 0.8 V or open).

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		MIL-	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16			Test limits	6
Subgroup	Symbol	STD-883 method	Test No.	1 Q	1D	2D	CLOCK 3-4	V _{cc}	3D	4D	4 Q	4Q	3Q	3 Q	GND	CLOCK 1-2	2 Q	2Q	1Q	Meas. terminal	Min	Max	Unit
9	t _{PLH1}	3003	66		IN-W			5.0 V							GND	А			OUT	1D-1Q	2	34	ns
T _C = 25°C	u	(Fig 4)	67			IN-W										А		OUT		2D-2Q			"
	u	"	68				А		IN-W				OUT							3D-3Q			"
	"	"	69				А			IN-W		OUT								4D-4Q			u
	t _{PLH2}	u	70	OUT	IN-X											А				1D-1 Q		44	u
			71			IN-X										А	OUT			2D-2 Q			"
	"	"	72				А		IN-X					OUT						3D-3 Q			"
	"	"	73				А			IN-X	OUT									4D-4 Q			"
	t _{PLH3}	3003	74		IN										"	IN			OUT	CLK 1-2-1Q		34	u
		(Fig 5)	75			IN										IN		OUT		CLK 1-2-2Q			"
			76				IN		IN				OUT							CLK 3-4-3Q			"
	"		77				IN			IN		OUT								CLK 3-4-4Q			"
	t _{PLH4}		78	OUT	IN											IN				CLK 1-2-1 Q		"	u
	"		79			IN										IN	OUT			CLK 1-2-2 Q			"
			80				IN		IN					OUT						CLK 3-4-3 Q			
	"		81				IN			IN	OUT				"					CLK 3-4-4 Q			"
	t _{PHL1}	3003	82		IN-X										"	А			OUT	1D-1Q		29	"
	"	(Fig 4)	83			IN-X										А		OUT		2D-2Q			u
	"	"	84				А		IN-X				OUT							3D-3Q			"
	u	u	85				А			IN-X		OUT								4D-4Q	-		u
	t _{PHL2}	u	86	OUT	IN-W											А				1D-1 Q		19	u
			87			IN-W										А	OUT			2D-2 Q			u
	"	"	88				А		IN-W					OUT						3D-3 Q			"
	"	"	89				А			IN-W	OUT									4D-4 Q			"
	t _{PHL3}	3003	90		IN			"							"	IN			OUT	CLK 1-2-1Q		"	u
1		(Fig 5)	91			IN										IN		OUT		CLK 1-2-2Q			"
1			92				IN		IN				OUT		"					CLK 3-4-3Q			u
1	u		93				IN			IN		OUT								CLK 3-4-4Q			u
1	t _{PHL4}		94	OUT	IN			"							"	IN				CLK 1-2-1 Q		"	u
1	"		95			IN									"	IN	OUT			CLK 1-2-2 Q			u
1			96				IN		IN					OUT						CLK 3-4-3 Q			
	"		97				IN			IN	OUT									CLK 3-4-4 Q			"

TABLE III. Group A inspection for device type 01. Terminal conditions (pins not designated may be H \geq 2.0 V or L \leq 0.8 V or open).

See footnotes at end of device type 01.

		MIL-	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16			Test limits	s
Subgroup	Symbol	STD-883 method	Test No.	1 Q	1D	2D	CLOCK 3-4	Vcc	3D	4D	4 Q	4Q	3Q	3 Q	GND	CLOCK 1-2	2 Q	2Q	1Q	Meas. terminal	Min	Max	Unit
10	t _{PLH1}	3003	98		IN-W			5.0 V							GND	A			OUT	1D-1Q	2	44	ns
T _C = 125°C	"	(Fig 4)	99			IN-W										А		OUT		2D-2Q			"
	"	"	100				А		IN-W				OUT							3D-3Q			"
	"	"	101				А			IN-W		OUT			"					4D-4Q			"
	t _{PLH2}	u	102	OUT	IN-X											А				1D-1 Q	"	55	"
			103			IN-X										А	OUT			2D-2 Q			"
	"	u	104				А		IN-X					OUT						3D-3 Q			"
	"	"	105				А			IN-X	OUT				"					4D-4 Q			"
	t _{PLH3}	3003	106		IN										"	IN			OUT	CLK 1-2-1Q		44	"
		(Fig 5)	107			IN										IN		OUT		CLK 1-2-2Q			u
			108				IN		IN				OUT							CLK 3-4-3Q			"
	"		109				IN			IN		OUT								CLK 3-4-4Q			"
	t _{PLH4}		110	OUT	IN										"	IN				CLK 1-2-1 Q	"		"
	"		111			IN									"	IN	OUT			CLK 1-2-2 Q			"
			112				IN		IN					OUT						CLK 3-4-3 Q			
	"		113				IN			IN	OUT				"					CLK 3-4-4 Q			"
	t _{PHL1}	3003	114		IN-X			"							"	А			OUT	1D-1Q		38	
	"	(Fig 4)	115			IN-X									"	А		OUT		2D-2Q			"
	"	u	116				А		IN-X				OUT		"					3D-3Q			"
	"	"	117				А			IN-X		OUT			"					4D-4Q			"
	t _{PHL2}	u	118	OUT	IN-W											А				1D-1 Q		25	"
			119			IN-W										А	OUT			2D-2 Q			"
	"	"	120				А		IN-W					OUT						3D-3 Q			"
	"	"	121				А			IN-W	OUT									4D-4 Q			"
	t _{PHL3}	3003	122		IN			-							"	IN			OUT	CLK 1-2-1Q			"
	"	(Fig 5)	123			IN		"							"	IN		OUT		CLK 1-2-2Q		•	"
			124				IN		IN				OUT							CLK 3-4-3Q			"
	"		125				IN	-		IN		OUT			"					CLK 3-4-4Q		"	"
	t _{PHL4}	"	126	OUT	IN			"							"	IN				CLK 1-2-1 Q			"
	"		127			IN		"							"	IN	OUT			CLK 1-2-2 Q		"	"
	"		128				IN	"	IN					OUT	"					CLK 3-4-3 Q		•	
	"		129				IN			IN	OUT				"					CLK 3-4-4 Q			"

TABLE III. Group A inspection for device type 01. Terminal conditions (pins not designated may be H \geq 2.0 V or L \leq 0.8 V or open).

See footnotes on next page.

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TABLE III. Group A inspection for device type 01. Terminal conditions (pins not designated may be $H \ge 2.0$ V or $L \le 0.8$ V or open).

NOTES:

A = Clock pulse A, see figure 4.

W and X = Various D-input pulses, see figure 4.

Only a summary of attributes data is required.

<u>1/</u> <u>2</u>/

- Only voltages shall be either: (a) H = 2.4 volts minimum and L = 0.4 volt maximum when using a high speed checker double comparator, or
 - (b) $H \ge 1.5$ volts and $L \le 1.5$ volts when using a high speed checker single comparator.

Subgroup	Symbol	MIL-	Case A,B,C,D	1	2	3	4	5	6	7	8	9	10	11	12	13	14	Meas.	Т	est lim	its
abgioap	0,11201	STD-883 method	Test No.	1D	2D	CLOCK 3-4	V_{CC}	3D	4D	NC	4Q	3Q	NC	GND	CLOCK 1-2	2Q	1Q	terminal	Min	Max	υ
1	VOH	3006	1	2.0 V			4.5 V							GND	2.0 V		-0.4 mA	1Q	2.4		,
T _C =25°C	"	"	2		2.0 V		"							"	2.0 V	-0.4 mA		2Q	"		
-	"	"	3			2.0 V		2.0 V				-0.4 mA		"				3Q	"		
	"	"	4			2.0 V	"		2.0 V		-0.4 mA			"				4Q	"		4
	Vol	3007	5	0.8 V			"							"	2.0 V		16 mA	1Q		0.4	6
	"	"	6		0.8 V									"	2.0 V	16 mA		2Q			•
	u	"	7			2.0 V		0.8 V				16 mA		"				3Q		"	4
	u	u	8			2.0 V	"		0.8 V		16 mA			"				4Q		"	"
	l _{IL1}	3009	9	0.4 V			5.5 V							"	4.5 V			1D	-1.4	-3.2	m
	"	"	10		0.4 V									"	4.5 V			2D	"		-
	"	"	11			4.5 V	"	0.4 V						"				3D	"	"	"
	"	"	12			4.5 V			0.4 V					"				4D	"	"	
	IIL2	"	13	0.8 V	0.8 V		"							"	0.4 V			CLK 1-2	-2.8	-6.4	-
	I _{IL2}	"	14			0.4 V	"	0.8 V	0.8 V					"				CLK 3-4	-2.8	-6.4	4
	l _{IH1}	3010	15	2.4 V			"							"	GND			1D		80	μ
	"	"	16		2.4 V									"	GND			2D			
	"	"	17			GND		2.4 V						"				3D			
	u	u	18			GND	"		2.4 V					"				4D			"
	I _{IH2}	"	19	5.5 V			"							"	GND			1D		200	**
	"	"	20		5.5 V									"	GND			2D			**
	"	"	21			GND		5.5 V										3D		"	**
	"	"	22			GND			5.5 V					"				4D			
	I _{IH3}	"	23	GND	GND		"							"	2.4 V			CLK 1-2		160	**
	IIH3	"	24			2.4 V	"	GND	GND					"				CLK 3-4		160	**
	liH4	u	25	GND	GND									"	5.5 V			CLK 1-2		400	**
	I _{IH4}	"	26			5.5 V		GND	GND									CLK 3-4		400	-
	los	3011	27	4.5 V			"							"	4.5 V		GND	1Q	-20	-57	m
	"	"	28		4.5 V									"	4.5 V	GND		2Q	"		
	"	"	29			4.5 V		4.5 V				GND						3Q			"
	"	"	30			4.5 V			4.5 V		GND	-						4Q	"		
	Icc	3005	31	GND	GND	GND	"	GND	GND		-			"	GND			V _{cc}		46	
	VIC		32	-12 mA	-	-	4.5 V	-	-					"	-			1D		-1.5	\
	*IC "		33		-12 mA													2D		"	
	"		34					-12 mA										3D			
	"		35				"		-12 mA					"				4D			
	"		36											"	-12 mA			CLK 1-2			
	"		37			-12 mA								"				CLK 3-4			
2	Same tests	terminal cor	nditions and limits a	as for subor	oun 1 exc		5°C and V.	o tests are i	omitted		1	1	1	1	1	1			L	I	4

TABLE III. Group A inspection for device type 02. Terminal conditions (pins not designated may be $H \ge 2.0$ V or $L \le 0.8$ V or open).

See footnotes at end of device type 02.

Subgroup	Symbol	MIL-	Case A,B,C,D	1	2	3	4	5	6	7	8	9	10	11	12	13	14	Meas.	Т	est lim	its
Subgroup	Symbol	STD-883 method	Test No.	1D	2D	CLOCK 3-4	V _{cc}	3D	4D	NC	4Q	3Q	NC	GND	CLOCK 1-2	2Q	1Q	terminal	Min	Max	Unit
7 <u>1</u> /	VLT-H1	see fig 4	38	IN-W			5.0 V							GND	Α		OUT	1D-1Q	2.4		V
T _C =25°C			39		IN-W									"	А	OUT		2D-2Q	"		"
_			40			А		IN-W				OUT		"				3D-3Q	"		"
			41			А			IN-W		OUT			"				4D-4Q	"		"
	VLT-L1		42	IN-X										"	Α		OUT	1D-1Q		0.4	"
			43		IN-X									"	Α	OUT		2D-2Q		"	"
			44			Α		IN-X				OUT		"				3D-3Q		"	**
			45			А			IN-X		OUT			"				4D-4Q		"	"
	VLT-H3	see fig 5	46	IN										"	IN-B		OUT	CLK 1-2-1Q	2.4		
	"		47		IN									"	IN-B	OUT		CLK 1-2-2Q	"		"
			48			IN		IN				OUT		"				CLK 3-4-3Q	"		**
			49			IN			IN		OUT			"				CLK 3-4-4Q	"		"
	VLT-L3		50	IN										"	IN-B		OUT	CLK 1-2-1Q		0.4	"
			51		IN									"	IN-B	OUT		CLK 1-2-2Q		"	**
			52			IN		IN				OUT		"				CLK 3-4-3Q		"	"
			53			IN	•		IN		OUT			"				CLK 3-4-4Q		"	"
8 <u>1</u> /	Same tests	s, terminal cor	nditions and limits a	as for subg	roup 7, exc	ept T _C = 12	5°C and -5	5°C.													
9	tPLH1	3003	54	IN-W			5.0 V							GND	Α		OUT	1D-1Q	2	34	ns
T _C =25°C		Fig 4-A	55		IN-W									"	Α	OUT		2D-2Q	"	"	"
		"	56			Α		IN-W				OUT		"				3D-3Q	"	"	**
	"	"	57			Α			IN-W		OUT			"				4D-4Q	"	"	"
	tPHL1	3003	58	IN-X										"	Α		OUT	1D-1Q	"	29	"
		Fig 4-B	59		IN-X									"	Α	OUT		2D-2Q	"	"	"
		"	60			Α		IN-X				OUT		"				3D-3Q	"	"	**
	"	"	61			Α			IN-X		OUT			"				4D-4Q	"	"	"
	t _{PLH3}	3003	62	IN			"							"	IN		OUT	CLK 1-2-1Q		34	"
	"	Fig 5	63		IN									"	IN	OUT		CLK 1-2-2Q	"	"	"
	"	"	64			IN		IN				OUT		"				CLK 3-4-3Q	"	"	"
	"	"	65			IN	-		IN		OUT			"				CLK 3-4-4Q	"	"	"
	t _{PHL3}	"	66	IN			"							"	IN		OUT	CLK 1-2-1Q	"	19	"
	"		67		IN									"	IN	OUT		CLK 1-2-2Q	"	"	"
		"	68			IN		IN				OUT		"				CLK 3-4-3Q	"	"	"
		"	69			IN			IN		OUT			"				CLK 3-4-4Q	"	"	"

TABLE III. Group A inspection for device type 02. Terminal conditions (pins not designated may be $H \ge 2.0$ V or $L \le 0.8$ V or open).

See footnotes at end of device type 02.

27

Subgroup	Symbol	MIL-	Case A,B,C,D	1	2	3	4	5	6	7	8	9	10	11	12	13	14	Meas.	T	est limi	its
Subgroup	Symbol	STD-883 method	Test No.	1D	2D	CLOCK 3-4	V_{CC}	3D	4D	NC	4Q	3Q	NC	GND	CLOCK 1-2	2Q	1Q	terminal	Min	Max	Unit
10	t _{PLH1}	3003	70	IN-W			5.0 V							GND	А		OUT	1D-1Q	2	44	ns
T _C = 125°C	"	Fig 4-A	71		IN-W		"							"	Α	OUT		2D-2Q	"		**
_	"		72			Α	"	IN-W				OUT		"				3D-3Q	"		**
	"	"	73			Α	"		IN-W		OUT							4D-4Q		"	"
	t _{PHL1}	3003	74	IN-X			"							"	А		OUT	1D-1Q	"	38	**
	"	Fig 4-B	75		IN-X		"							"	А	OUT		2D-2Q	"	"	"
	"	"	76			Α	"	IN-X				OUT						3D-3Q			"
	"	"	77			Α	"		IN-X		OUT			"				4D-4Q	-	-	"
	t _{PLH3}	3003	78	IN			"							"	IN		OUT	CLK 1-2-1Q		44	"
	"	Fig 5	79		IN		"							"	IN	OUT		CLK 1-2-2Q	"	"	"
	"	"	80			IN	"	IN				OUT						CLK 3-4-3Q			"
	"	"	81			IN	"		IN		OUT			"				CLK 3-4-4Q	-	-	"
	t _{PHL3}		82	IN			"							"	IN		OUT	CLK 1-2-1Q		25	"
	"	"	83		IN		"								IN	OUT		CLK 1-2-2Q			"
	"	"	84			IN	"	IN				OUT						CLK 3-4-3Q			"
	"		85			IN	"		IN		OUT			"				CLK 3-4-4Q		"	"

TABLE III. Group A inspection for device type 02. Terminal conditions (pins not designated may be $H \ge 2.0$ V or $L \le 0.8$ V or open).

28 NOTES:

A = Clock pulse A, see figure 4. W and X = Various D-input pulses, see figure 4.

<u>1</u>/ Latch voltage, V_{LT} , shall be measured no sooner than 10 µs after switching transition occurs.

		MIL-	Case J, K, L, Z		2	3	4	5	6	7	8	9	10	11	12			Test limit	ts
Subgroup	Symbol	STD-883 method	Test No.	1 MR	1 Ē 0	1 Ē 1	1D0	1Q0	1D1	1Q1	1D2	1Q2	1D3	1Q3	GND	Meas. terminal	Min	Max	Unit
1	V _{OH}	3006	1	4.5 V	0.8 V	0.8 V	4.5 V	-0.8 mA	4.5 V		4.5 V		4.5 V		GND	1Q0	2.4		V
T _C = 25°C			2							-0.8 mA					"	1Q1			
"			3									-0.8 mA			"	1Q2			
"	и		4									0.0		-0.8 mA	"	1Q3			"
"	u		5												"	2Q0			"
"	u		6		"	"	"						"		"	2Q1			"
"	u		7	:											"	2Q2			"
"	V _{OL}	3007	8				0.8 V	16 mA	0.8 V		0.8 V		0.8 V		"	2Q3 1Q0		0.4	"
"	VOL "	"	10				0.0 V	TOTIA	0.0 V	16 mA	0.0 V		0.0 V "		"	1Q0		0.4 "	"
"	и		10							10 IIIA		16 mA	"		и	1Q2		"	"
"	u		12											16 mA	"	1Q3		"	"
"	u		13		"	"	"						"		"	2Q0		"	"
"	u u		14												"	2Q1 2Q2		"	"
"	и		15 16												"	2Q2 2Q3		"	"
"	VIC		17	-12 mA											u			-1.5	"
"	"		18		-12 mA										"			"	"
"	u		19			-12 mA									"	1 E 1		"	"
"	и		20			-12 11/4	-12 mA								"	1 E 1 1D0		"	"
"	и		20				-12 IIIA		-12 mA						"	1D0 1D1		"	"
"	u		22								-12 mA				и	1D2		"	"
"	u		23										-12 mA		"	1D3		"	"
"			24												"	2 MR			
"			25												"	2 Ē 0		**	"
"	"		26												"	2 Ē 1		"	"
"			27												"	2D0		"	"
"	"		28												"	2D1		"	"
"			29												"	2D2		"	"
			30												"	2D3			
"	l _{IL1}	3009	31 CKT A	GND "	GND		0.4 V								"	1D0	-0.7	-2.4	mA "
			31 CKT B												"	1D0	-0.7	-1.6	
			31 CKT C						0.414						"	1D0	-0.5	-1.4	"
"			32 CKT A						0.4 V "						"	1D1	-0.7	-2.4	
	"		32 CKT B												"	1D1	-0.7	-1.6	"
"	и	**	32 CKT C 33 CKT A								0414				"	1D1 1D2	-0.5	-1.4	"
"	и	"	33 CKT A 33 CKT B								0.4 V "				"	1D2 1D2	-0.7 -0.7	-2.4 -1.6	"
"	и	"	33 CKT B 33 CKT C												"	1D2 1D2	-0.7	-1.0	"
"	и	"	34 CKT A										0.4 V		"	1D2 1D3	-0.5	-1.4	"
"	и	**	34 CKT B										"		"	1D3	-0.7	-1.6	"
"	u	**	34 CKT C										"		"	1D3	-0.5	-1.4	"
"	"	**	35 CKT A												"	2D0	-0.7	-2.4	"
"	u u	"	35 CKT B												"	2D0	-0.7	-1.6	"
"	и	44	35 CKT C 36 CKT A													2D0 2D1	-0.5 -0.7	-1.4 -2.4	"
"	u	**	36 CKT A 36 CKT B												u	2D1 2D1	-0.7	-2.4 -1.6	"
"	u	"	36 CKT C												"	2D1	-0.5	-1.4	"

TABLE III. Group A inspection for device type 03. Terminal conditions (pins not designated may be H \ge 2.0 V, or L \le 0.8 V, or open).

Symbol methods Test No. 2 kar		MIL-	Case J, K, L, Z	13	14	15	16	17	18	19	20	21	22	23	24			Test limit	.s
VpH 3006 1 4.5V 0.8V 0.8V 4.5V 4.5V 4.5V 6.5V 0.8D 100 2.4 V 1 2 -	Symbol	STD-883 method		2 MP	2 Ē 0		2D0	2Q0	2D1	2Q1	2D2	2Q2	2D3	2Q3	V _{CC}	Meas. terminal	Min	Max	Unit
<td>Vон</td> <td>-</td> <td>1</td> <td></td> <td></td> <td></td> <td>4.5 V</td> <td></td> <td>4.5 V</td> <td></td> <td>4.5 V</td> <td></td> <td>4.5 V</td> <td></td> <td></td> <td></td> <td>2.4</td> <td></td> <td>V</td>	Vон	-	1				4.5 V		4.5 V		4.5 V		4.5 V				2.4		V
<td></td> <td></td> <td>2</td> <td></td>			2																
1 1 3 1 <th1< th=""> 1 1 1 1<td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td>"</td><td></td><td></td><td></td><td></td></th1<>															"				
1 1 6 1 1 1 1 1 1 0.8 m 1 <td>66</td> <td></td> <td>"</td>	66																		"
· ·	"							-0.8 mA											"
· ·	"									-0.8 mA		-0.8 mA							"
Vol. Soluri Soluri <td>66</td> <td></td> <td>0.0 11.0 (</td> <td></td> <td>-0.8 mA</td> <td>"</td> <td></td> <td></td> <td></td> <td>"</td>	66											0.0 11.0 (-0.8 mA	"				"
1 10 1	VOL	3007	9	"	"	"	0.8 V		0.8 V		0.8 V		0.8 V			1Q0		0.4	"
1 1	u																	"	"
1 1 <th1< th=""> <th1< th=""> <th1< th=""></th1<></th1<></th1<>	u														"			"	"
1 1 <th1< th=""> <th1< th=""> <th1< th=""></th1<></th1<></th1<>	"							16 mA							u			"	"
· ·			14							16 mA					"	2Q1		"	"
Vic 17 18 18 19 11 10 1.5 1 19 12 mA 19 11 10 1	"											16 mA		16 m A				"	"
18 18 18	Vie													TOTILA	u			-15	"
10 10<															u				"
1 20 21 22 3 20 21 23 3 20 21 23 3 20 21 3 20 21 3 20 23 3 20 3 <																			"
1 21 22 23 12 mA	"														"				"
· ·	"														"			"	"
1 12 12 A	и																	"	"
" 25 -12 mA	"														u	1D3		"	"
" 26 -12 mA			24	-12 mA											"	2 MR			
" 27 L L -12 mA -12 mA <td></td> <td></td> <td>25</td> <td></td> <td>-12 mA</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>u</td> <td>2 Ē 0</td> <td></td> <td>"</td> <td>"</td>			25		-12 mA										u	2 Ē 0		"	"
" 28 -12 mA -12 mA -12 mA -12 mA 200 -1 -1 -12 mA			26			-12 mA									"	2 Ē 1		"	"
"" 29 "" 29 """ """ """ """" """"""""""""""""""""""""""""""""""""			27				-12 mA								u	2D0		"	"
" 223 30 " <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>-12 mA</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>"</td> <td>"</td>									-12 mA									"	"
Image: Note of the i											-12 mA		10						"
		3000											-12 mA				0.7		m۸
"" 31 CKT C 1D0 .0.5 .1.4 "" "" 32 CKT A <td>۱L1 "</td> <td></td> <td>"</td> <td></td> <td></td> <td></td> <td></td>	۱L1 "														"				
"" 32 CKT A <	"	"													"				"
"" 32 CKT B <	"	"													"				"
"" 33 CKT A <	"	"													"	1D1		-1.6	"
"" 33 CKT B <	u	"													"				"
"" 33 CKT C <	"	"													"				"
" 34 CKT A 1D3 -0.7 -2.4 " " 34 CKT B	"	"													"				"
"" 34 CKT B "" 1D3 -0.7 -1.6 "" "" 34 CKT C "" 1D3 -0.7 -1.4 "" "" 35 CKT A GND GND -0.4 V "" 2D0 -0.7 -2.4 "" "" 35 CKT B "" "" "" "" 2D0 -0.7 -2.4 "" "" 35 CKT B "" "" "" "" 2D0 -0.7 -1.6 "" "" 35 CKT C "" "" "" "" "" 2D0 -0.7 -1.6 "" "" 36 CKT A "" <td>"</td> <td>"</td> <td></td> <td>"</td> <td></td> <td></td> <td></td> <td>"</td>	"	"													"				"
"" 34 CKT C "" 1D3 -0.5 -1.4 "" "" 35 CKT A GND GND "" "" 2D0 -0.7 -2.4 "" "" 35 CKT B "" "" "" 2D0 -0.7 -2.4 "" "" 35 CKT C "" "" "" "" 2D0 -0.7 -1.6 " "" 36 CKT A "" "" -0.4 V "" "" 2D1 -0.7 -1.4 "" "" 36 CKT B "" "" "" -0.4 V "" "" 2D1 -0.7 -1.4 "" "" 36 CKT B "" "" "" "" "" 2D1 -0.7 -1.4 "" "" 36 CKT B "" "" "" "" "" 2D1 -0.7 -1.4 ""	"	"																	"
"" 35 CKT A GND GND -0.4 V "" 2D0 -0.7 -2.4 "" "" 35 CKT B "" "" "" "" 2D0 -0.7 -1.6 "" "" 35 CKT C " " " "" 2D0 -0.7 -1.6 "" "" 36 CKT A " " -0.4 V " "" 2D1 -0.7 -2.4 " " 36 CKT B " " " -0.4 V " " 2D1 -0.7 -1.6 "	u	"	34 CKT C												-				
" 35 CKT C " " " 2D0 -0.5 -1.4 " " 36 CKT A " " -0.4 V " " 2D1 -0.7 -2.4 " " 36 CKT B " " " " 2D1 -0.7 -2.4 "	"	"		GND "	GND "		-0.4 V								-				
" 36 CKT A " " 36 CKT A " " " -0.4 V " 36 CKT B " " " -1.6 "	"	"													u				"
30 CK IB 2DI -0.7 -1.0	"	u	36 CKT A						-0.4 V						"	2D1	-0.7	-2.4	"
	"	"	36 CKT B 36 CKT C												"	2D1 2D1	-0.7 -0.5	-1.6 -1.4	"

TABLE III. Group A inspection for device type 03. Terminal conditions (pins not designated may be H \ge 2.0 V, or L \le 0.8 V, or open).

Subgroup 1 T_C = 25°C " " " " " " " " " " " " " " " " " "

> " " " " " " "

> " " " " " " " " " " " " " " " " " " "

> "

Subgroup	Symbol	MIL- STD-883	Case J, K, L, Z	1	2	3	4	5	6	7	8	9	10	11	12	Meas.		Test limit	ts
Subgroup	Symbol	method	Test No.	1 MR	1 Ē 0	1 Ē 1	1D0	1Q0	1D1	1Q1	1D2	1Q2	1D3	1Q3	GND	terminal	Min	Max	Unit
1	I _{IL1}	3009	37 CKT A												GND	2D2	-0.7	-2.4	mA
T _C = 25°C	"	"	37 CKT B												"	2D2	-0.7	-1.6	"
"	"	"	37 CKT C												"	2D2	-0.5	-1.4	"
"	"	"	38 CKT A												"	2D3	-0.7	-2.4	"
"	"	"	38 CKT B												"	2D3	-0.7	-1.6	"
"	"	u	38 CKT C												"	2D3	-0.5	-1.4	"
	I _{IL2}	"	39	0.4 V												1 MR	-0.7	-1.6	
			40		0.4 V	5.5 V									"	1 Ē 0			
"		"	41		5.5 V	0.4 V									"	1 Ē 1			
"	"		42			-									"	2 MR			"
"	"		43												"	2 MR 2 E 0			"
"	"		44												"	2 E 0 2 E 1			"
u	liH1	3010	45 CKT A			5.5 V	2.4 V								"	1D0		40	μA
"	"	"	45 CKT B, C				2.4 V								"	1D0		80	
"	"	"	46 CKT A						2.4 V						"	1D1		40	"
"	"	"	46 CKT B, C						2.4 V						"	1D1		80	"
"	"	"	47 CKT A						2.4 0		2.4 V				"	1D2		40	"
"	"	"	47 CKT B, C								2.4 V				"	1D2		80	"
"	"	"	48 CKT A										2.4 V		"	1D3		40	"
"	"	"	48 CKT B, C										2.4 V		"	1D3		80	"
u	"	"	49 CKT A												"	2D0		40	"
"	"	"	49 CKT B, C												"	2D0		80	"
u	"	"	50 CKT A												"	2D1		40	"
u	"	"	50 CKT B, C												"	2D1		80	"
"	"		51 CKT A												"	2D2		40	44
"	"		51 CKT B, C												"	2D2		80	"
"	"		52 CKT A												"	2D3		40	"
"	"	"	52 CKT B, C												"	2D3		80	"
u	I _{IH2}	3010	53 CKT A			5.5 V	5.5 V								"	1D0		100	"
"	"	"	53 CKT B, C				5.5 V								"	1D0		200	"
"	"	u	54 CKT A						5.5 V						"	1D1		100	"
u	"	"	54 CKT B, C						5.5 V						"	1D1		200	"
"	"	"	55 CKT A						5.5 V		5.5 V				"	1D1		100	"
"	"	"	55 CKT B, C								5.5 V				"	1D2		200	**
"	"	"	56 CKT A								0.0 1		5.5 V		"	1D3		100	**
"	"	"	56 CKT B, C										5.5 V		"	1D3		200	"
"	"	"	57 CKT A										0.0 V		"	2D0		100	"
"	"	"	57 CKT B, C												"	2D0		200	"
"	"	"	58 CKT A												"	2D1		100	"
"	"	"	58 CKT B, C												"	2D1		200	"
"	"		59 CKT A												"	2D2		100	"
"	**		59 CKT B, C												"	2D2		200	"
"	"	"	60 CKT A												"	2D3		100	"
"	"	"	60 CKT B, C	I			1								"	2D3		200	"

TABLE III. Group A inspection for device type 03. Terminal conditions (pins not designated may be H \geq 2.0 V, or L \leq 0.8 V, or open).

		MIL-	Case J, K, L, Z	13	14	15	16	17	18	19	20	21	22	23	24			Test limit	íS
Subgroup	Symbol	STD-883 method	Test No.	$2 \overline{MR}$	2 Ē 0	2Ē1	2D0	2Q0	2D1	2Q1	2D2	2Q2	2D3	2Q3	V _{cc}	Meas. terminal	Min	Max	Unit
1	I _{IL1}	3009	37 CKT A	GND	GND						0.4 V				5.5 V	2D2	-0.7	-2.4	mA
T _C = 25°C	"LI	"	37 CKT B												"	2D2	-0.7	-1.6	"
"	"	"	37 CKT C												"	2D2	-0.5	-1.4	и
u	"	u	38 CKT A										0.4 V		"	2D2 2D3	-0.7	-1.4	"
"	"	"	38 CKT B										0. 4 V "		"	2D3	-0.7	-1.6	"
"	"	"	38 CKT C												"	2D3 2D3	-0.7	-1.4	"
	I _{IL2}		39													1 MR	-0.7	-1.6	
	ILZ														"				
			40													1 Ē 0			
"		"	41												"	1 Ē 1			"
"	"		42	0.4 V											"	2 MR			"
"	"		43		0.4 V	5.5 V									"	2 Ē 0			"
"	"		44		5.5 V	0.4 V									"	2 Ē 1			"
"	liH1	3010	45 CKT A												ű	1D0		40	μA
"	"	"	45 CKT B, C												"	1D0		80	"
"	"	"	46 CKT A												"	1D1		40	"
"	"	"	46 CKT B, C												"	1D1		80	"
u	"	"	47 CKT A												"	1D2		40	"
"	"	"	47 CKT B, C												"	1D2		80	**
"	"	"	48 CKT A												"	1D3		40	"
"	"	u	48 CKT B, C												"	1D3		80	"
"	"		49 CKT A			5.5 V	2.4 V								"	2D0		40	"
		"	49 CKT B, C				2.4 V								"	2D0		80	
"	"	"	50 CKT A						2.4 V						"	2D1		40	"
			50 CKT B, C						2.4 V		0.414				"	2D1		80	"
"	"		51 CKT A								2.4 V 2.4 V				"	2D2 2D2		40 80	"
"	"		51 CKT B, C 52 CKT A								2.4 V		2.4 V		"	2D2 2D3		40	"
"	"		52 CKT B, C										2.4 V 2.4 V		"	2D3		80	"
"	I _{IH2}	3010	53 CKT A												u	1D0		100	"
"	"	"	53 CKT B, C												"	1D0		200	"
u	"	u	54 CKT A												"	1D1		100	"
u	"	"	54 CKT B, C												"	1D1		200	"
"	"	"	55 CKT A												"	1D2		100	"
u	"	"	55 CKT B, C												"	1D2		200	"
ш	"	"	56 CKT A												"	1D3		100	"
u	"	u	56 CKT B, C												"	1D3		200	"
"	"	"	57 CKT A			5.5 V	5.5 V								"	2D0		100	"
u	"	u	57 CKT B, C			"	5.5 V								"	2D0		200	"
"	"	"	58 CKT A						5.5 V						"	2D1		100	"
"	"	"	58 CKT B, C						5.5 V						"	2D1		200	"
"	"	:	59 CKT A								5.5 V				"	2D2		100	"
	"		59 CKT B, C								5.5 V		E E V		"	2D2 2D3		200	
u	"		60 CKT A 60 CKT B, C										5.5 V 5.5 V		"	2D3 2D3		100 200	"

TABLE III. Group A inspection for device type 03. Terminal conditions (pins not designated may be H \geq 2.0 V, or L \leq 0.8 V, or open).

		MIL-	Case J, K, L, Z	1	2	3	2 pins no	5 5		аурен	<u>> 2.0 V</u> 8	, <u>01 L <</u> 9	0.8 V, C	11	. 12			Test limit	is.
Subgroup	Symbol	STD-883 method	Test No.	1 MR	1 Ē 0	1 Ē 1	1D0	1Q0	1D1	, 1Q1	1D2	1Q2	1D3	1Q3	GND	Meas.	Min	Max	Unit
					1 E 0	1E 1	TDU	1020		TQT	102	102	105	1025		terminal	IVIIII		-
1	I _{IH3}	3010	61	2.4 V											GND	1 MR		40	μA
T _C = 25°C			62		2.4 V	GND									"	1 Ē 0			"
ű		"	63		GND	2.4 V									"	1 Ē 1			"
"	**	"	64												u	2 MR			"
"	66	"	65												"	2 Ē 0			**
"	66		66												"	2 Ē 1			"
	I _{IH4}	"	67	5.5 V											"	1 MR		100	"
		"	68		5.5 V	GND									"	1 Ē 0			
"		"	69		GND	5.5 V									"	1 Ē 1			
"	"		70												u	2 MR			"
"	66	•	71												"	2 Ē 0			"
u	"		72												"	2 Ē 1			"
"	los	3011	73	4.5 V	GND	GND	4.5 V	GND	4.5 V		4.5 V		4.5 V		"	1Q0	-10 <u>1</u> /	-70	mA
"	**	"	74							GND					u	1Q1			"
"	"	"	75									GND			"	1Q2			"
"	"	"	76 77											GND	"	1Q3 2Q0			"
"	"	"	78												"	2Q0 2Q1			"
"	"	"	79												u	2Q2			"
"	"	u	80		"		"				"		"		"	2Q3			u
"	I _{CC}	3005	81	4.5 V	4.5 V	4.5 V	4.5 V		4.5 V		4.5 V		4.5 V		"	V _{CC}		106	mA
2	Same test	ts, terminal con	nditions and limits nditions and limits	as for sub	group 1, e group 1, e	except Ic	= 125°C a = -55°C ar	nd V _{IC} test	s are omit	ted.									
9	t _{PLH1}	3003	82	5.0 V	IN	GND	IN	OUT							GND	1 E 0-1Q0	3	33	ns
T _C = 25°C	"	Fig 6-B	83						IN	OUT					"	1 E 1-1Q1			"
	"	"	84								IN	OUT			"	1 E 2-1Q2			"
"	66		85										IN	OUT	"	1 E 3-1Q3			"
"	"		86		GND	IN	IN	OUT							"	1 Ē 0-1Q0			"
"			87						IN	OUT					"	1 Ē 1-1Q1			
"	66	u	88								IN	OUT			"	1 E 2-1Q2			**
"	66	u	89										IN	OUT	u	1 E 3-1Q3			**
"	"	ű	90												"	2 E 0-2Q0			"
"	"	"	91												и	2 E 0-2Q0 2 E 1-2Q1			"
"	"	ű	91												"				"
"	**	"	92 93												"	2 Ē 2-2Q2 2 Ē 3-2Q3			"
"	"	"	93 94												"	2 E 3-2Q3 2 E 0-2Q0			"
"	"	"	94 95												"				"
"	**	"	95 96												"	2 Ē 1-2Q1			"
"		"													"	2 E 2-2Q2			"
-		-	97													2 E 3-2Q3			

TABLE III. Group A inspection for device type 03. Terminal conditions (pins not designated may be H \geq 2.0 V, or L \leq 0.8 V, or open).

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$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	Subgroup	Symbol		Case J, K, L, Z		2	3	4	5	6	7	8	9	10	11	12	Meas.	Test limits		s
T ₀ =25°C ·	Subgroup	Symbol		Test No.	2 MR	2Ē0	2Ē1	2D0	2Q0	2D1	2Q1	2D2	2Q2	2D3	2Q3	V _{CC}		Min	Max	Unit
I (c = 20 C)	1	I _{IH3}	3010	61												5.5 V	1 MR		40	μA
· ·	T _C = 25°C			62												"	1 Ē 0			"
- - - 64 2.4 V GND - - - 2 MR - - - 2 MR - - - 2 MR - - - - 2 mR -	"			63												"	1Ē1			
· ·	**	"		64	2.4 V											"				"
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	"	"		65		2.4 V	GND									"				"
Image: Normal conditions and limits as for subgroup 1, except 1, e = 25° cand V ₄ , tests are omitted. 4.5 V 4.5 V 4.5 V 4.5 V 4.5 V 2.5 V 1 IMT 1 000		"		66		GND	2.4 V									"	_			"
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$		I _{IH4}	"	67												"			100	"
<td>-</td> <td></td> <td></td> <td>68</td> <td></td> <td>"</td> <td></td> <td></td> <td></td> <td></td>	-			68												"				
· ·	"			69												"				
· ·	**	"		70	5.5 V											"				u
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	"	"		71		5.5 V	GND									"				u
Image:	"	"		72		GND	5.5 V									"				u
- - - 74 * * * * * * * * * 1 101 *		los	3011	73	4.5 V	GND	GND	4.5 V		4.5 V		4.5 V		4.5 V		"		-10 <u>1</u> /	-70	mA
- - - 76 - - - - 103 - - - 103 - - - - 103 - - - - 103 - - - 103 - - - 103 - - - 103 - - - 103 - - - 103 - - - 103 - - - 103 - - - 103 - - - 103 - - - 103 - - - 103 - - - 103 - - - 103 - - - - 103 - - - - - 103 - - - - - 103 -<	**	"	"							"										u
- - - 77 * * * GND * GND * - - 200 * * - - - 200 * * - - - 200 * * - - - 200 * * - - - 200 * * - - - 200 * * - - - 200 * * - - - 200 * * - - - - 200 * * - - - 200 * * - - - 200 * * - - - - 200 * * - - - - 200 * * -	"	"	"																	u
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	"	"	"						GND							66				u
- -	"	"	"	78					-		GND					66	2Q1			u
ICC 3005 81 4.5 V 4.5 V 4.5 V 4.5 V 4.5 V 4.5 V VCC 106 mA 2 Same tests, terminal conditions and limits as for subgroup 1, except T _c = 125°C and V _{ic} tests are omitted. - VCC 106 mA 3 Same tests, terminal conditions and limits as for subgroup 1, except T _c = 125°C and V _{ic} tests are omitted. - - - - - - 106 mA 9 tpLH1 3003 82 5.0 V -<	"	"	"										GND		GND	"				u
2 Same tests, terminal conditions and limits as for subgroup 1, except T _C = 125°C and V _{IC} tests are omitted. 3 Same tests, terminal conditions and limits as for subgroup 1, except T _C = -55°C and V _{IC} tests are omitted. 9 tPLH1 3003 82 5.0 V 1 E 0.0 V	"	Icc	3005		4.5 V	4.5 V	4.5 V	4.5 V		4.5 V		4.5 V		4.5 V	GND	u			106	mA
9 tp:H1 3003 82 5.0 V 1 = 0.100 3 33 ns T_C = 25°C Fig 6-B 83		Same tes	ts, terminal co	nditions and limits	as for sub	group 1, e	xcept T _c :	= 125°C ai	nd V _{IC} test	s are omit	ted.						00			
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$						group 1, e	xcept T _c =	-55°C an	d V _{IC} tests	are omitte	ed.	1	1	1	1	1	_			<u> </u>
T _C = 25°C - - 1 <td< td=""><td></td><td>tPLH1</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td>3</td><td>33</td><td></td></td<>		tPLH1																3	33	
-	T _C = 25°C		Fig 6-B																	
				84													_			
	**	"	"	85												66	1 E 3-1Q3			ű
	**	"		86												66	1 Ē 0-1Q0			"
	**		"	87												"	1 Ē 1-1Q1			
""""""""""""""""""""""""""""""""""""	"	"	"	88												"	1 E 2-1Q2			"
	"	"	"	89												66	1 E 3-1Q3			"
""" "" <t< td=""><td>**</td><td>"</td><td>"</td><td>90</td><td></td><td>IN</td><td>GND</td><td>IN</td><td>OUT</td><td></td><td></td><td></td><td></td><td></td><td></td><td>"</td><td>2 Ē 0-2Q0</td><td></td><td></td><td>u</td></t<>	**	"	"	90		IN	GND	IN	OUT							"	2 Ē 0-2Q0			u
""" "" <t< td=""><td></td><td>"</td><td>"</td><td>91</td><td></td><td></td><td></td><td></td><td></td><td>IN</td><td>OUT</td><td></td><td></td><td></td><td></td><td>"</td><td></td><td></td><td></td><td>u</td></t<>		"	"	91						IN	OUT					"				u
""" "" <t< td=""><td>**</td><td>"</td><td>"</td><td>92</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td>IN</td><td>OUT</td><td></td><td></td><td>"</td><td>2 Ē 2-2Q2</td><td></td><td></td><td>"</td></t<>	**	"	"	92								IN	OUT			"	2 Ē 2-2Q2			"
""" "" 94 "" GND IN IN OUT "" "" 2 \overline 0.200 "" <td< td=""><td>"</td><td>"</td><td>"</td><td>93</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td>IN</td><td>OUT</td><td>66</td><td></td><td></td><td></td><td>u</td></td<>	"	"	"	93										IN	OUT	66				u
""""""""""""""""""""""""""""""""""""	"	"		94		GND	IN	IN	OUT											"
" " " 96 " " " " IN OUT " 2 E 2-2Q2 " " "	"	ű	"	95	"					IN	OUT					"				"
	**	"	"	96	"							IN	OUT			66	_			"
	"	ű	"	97	"									IN	OUT		2 Ē 3-2Q3			u

TABLE III.Group A inspection for device type 03.Terminal conditions (pins not designated may be H \geq 2.0 V, or L \leq 0.8 V, or open).

 $\underline{1}/$ Circuit B and C limits for I_OS shall be -20, minimum and -57, maximum.

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Subgroup	Symbol	MIL- STD-883	Case J, K, L, Z	1	2	3	4	5	6	7	8	9	10	11	12	Meas.		Test limit	is
Subgroup	Symbol	method	Test No.	$1 \overline{MR}$	1 Ē 0	1 Ē 1	1D0	1Q0	1D1	1Q1	1D2	1Q2	1D3	1Q3	GND	terminal	Min	Max	Unit
9	tPHL1	3003	98	5.0 V	IN	GND	IN	OUT							GND	1 Ē 0-1Q0	3	25	ns
T _C = 25°C	"	Fig 6-A	99						IN	OUT					**	1 Ē 1-1Q1			"
и	"	"	100	"							IN	OUT			"	1 E 2-1Q2			"
ш	"		101										IN	OUT	"	1 E 3-1Q3		"	"
u	"		102		GND	IN	IN	OUT							"	1 E 0-1Q0			"
u			103						IN	OUT					"	1 E 1-1Q1		"	"
"	"	"	104								IN	OUT			"	1 Ē 2-1Q2			"
"	"	"	105										IN	OUT	"	1 E 3-1Q3			"
"	"	"	106	"											"	2 E 0-2Q0			"
ш	"	"	107												"	2 E 1-2Q1			"
ш	"	"	108												"	2 E 2-2Q2			"
u	"	"	109												"	2 E 3-2Q2			"
ш	"		110												"	2 E 3-2Q3 2 E 0-2Q0			"
и	"	"	110												"	_			"
"	"	"	112												"	2 E 1-2Q1			"
u	"	"	112												"	2 E 2-2Q2			"
		3003	113		IN	GND	IN	OUT							"	2 E 3-2Q3 1D0-1Q0		33	"
	t _{PLH2}	Fig 6	114		"	GND "	IIN	001	IN	OUT					"	1D1-1Q1		"	"
"	"	"	116							001	IN	OUT			**	1D2-1Q2			"
"	"	"	117	"									IN	OUT	**	1D3-1Q3			"
u	"	"	118		GND	IN	IN	OUT							"	1D0-1Q0	"		"
u	"		119		"				IN	OUT					"	1D1-1Q1	"	"	
"	"	"	120								IN	OUT		0.UT	"	1D2-1Q2			"
	"		121										IN	OUT	"	1D3-1Q3 2D0-2Q0			
	65	"	122												"	2D0-2Q0 2D1-2Q1			"
		"	123												"	2D2-2Q2			"
			124													2D2-2Q2 2D3-2Q3			
"	"	"	125												"		"	"	"
u	"	"	126												"	2D0-2Q0	"	"	"
"	**	"	127												"	2D1-2Q1	"	"	"
u	**	"	128												"	2D2-2Q2	"	"	"
"	"	"	129												"	2D3-2Q3	-		"

TABLE III. Group A inspection for device type 03. Terminal conditions (pins not designated may be H \geq 2.0 V, or L \leq 0.8 V, or open).

Cubaraun	Cumphel	nbol STD-883 method	Case J, K, L, Z	13	14	15	16	17	18	19	20	20 21		23	24	Maga		Test limits				
Subgroup	Symbol		Test No.	2 MR	2 Ē 0	2 Ē 1	2D0	2Q0	2D1	2Q1	2D2	2Q2	2D3	2Q3	Vcc	Meas. terminal	Min	Max	Unit			
9	tPHL1	3003	98	5.0 V											5.0 V	1 Ē 0-1Q0	3	25	ns			
T _C = 25°C	u	Fig 6-A	99												**	1 Ē 1-1Q1			"			
"	"		100												**	1 Ē 2-1Q2		"	"			
"	"		101												66	1 Ē 3-1Q3		"	"			
"	"		102												"	1 E 0-1Q0			"			
"			103												"	1 Ē 1-1Q1			"			
"	"	"	104												"	1 E 2-1Q2			"			
"	"	"	105												"	1 E 3-1Q3			"			
"	"	"	106		IN	GND	IN	OUT							"	2 Ē 0-2Q0			"			
"	"	"	107						IN	OUT					"	2 Ē 1-2Q1			"			
и	u	"	108								IN	OUT			66	2 E 2-2Q2			"			
"	"	"	109										IN	OUT	"	2 Ē 3-2Q3			"			
"	"	"	110		GND	IN	IN	OUT							"	2 Ē 0-2Q0			"			
"	"	"	111						IN	OUT					"	2 Ē 1-2Q1			"			
"	"	"	112								IN	OUT			"	2 Ē 2-2Q2			"			
"	"	"	113										IN	OUT	"	2 E 3-2Q3			"			
	t _{PLH2}	3003	114													1D0-1Q0		33				
	u	Fig 6	115												66	1D1-1Q1			"			
"	u		116												"	1D2-1Q2			"			
"	"		117												"	1D3-1Q3		"	"			
			118												"	1D0-1Q0 1D1-1Q1						
"	u	"	119 120												"	1D1-1Q1 1D2-1Q2			"			
"	u	"	120												"	1D3-1Q3			"			
"	u	"	121		IN	GND	IN	OUT							66	2D0-2Q0			"			
и	u	"	123						IN	OUT					"	2D1-2Q1			"			
"	"	ű	124								IN	OUT			"	2D2-2Q2			"			
"	u	"	125										IN	OUT	"	2D3-2Q3			"			
"	"	"	126		GND	IN	IN	OUT							66	2D0-2Q0			"			
"	u	"	127						IN	OUT					66	2D1-2Q1			"			
"	"	"	128								IN	OUT			"	2D2-2Q2			"			
"	u	"	129										IN	OUT	"	2D3-2Q3			"			

TABLE III. Group A inspection for device type 03. Terminal conditions (pins not designated may be H \ge 2.0 V, or L \le 0.8 V, or open).

/leas.		Test limit	s
rminal	Min	Max	Unit
00-1Q0	3	28	ns
)1-1Q1			"
)2-1Q2			"
)3-1Q3			u
00-1Q0			"
)1-1Q1			
)2-1Q2			"
)3-1Q3			"
00-2Q0			"
01-2Q1			u
2-2Q2			"
)3-2Q3			u
0-2Q0			u
)1-2Q1			u
2-2Q2			u
03-2Q3			u
IR -1Q0		25	
IR -1Q1			u
IR -1Q2			u
IR -1Q3			u
100			u

TABLE III. Group A inspection for device type 03.
Terminal conditions (pins not designated may be $H \ge 2.0$ V, or $L \le 0.8$ V, or open).

Subgroup	Symbol	MIL- STD-883	Case J, K, L, Z	1	2	3	4	5	6	7	8	9	10	11	12	Meas.		Test limit	ts
Subgroup	Symbol	method	Test No.	1 MR	1 Ē 0	1 Ē 1	1D0	1Q0	1D1	1Q1	1D2	1Q2	1D3	1Q3	GND	terminal	Min	Max	Unit
9	tPHL2	3003	130	5.0 V	IN	GND	IN	OUT							GND	1D0-1Q0	3	28	ns
$T_C = 25^{\circ}C$	"	Fig 6	131	"					IN	OUT					"	1D1-1Q1	"		"
"	"	"	132								IN	OUT			"	1D2-1Q2	"		"
"	65	"	133		"								IN	OUT	"	1D3-1Q3	"		"
u	"		134 135		GND	IN "	IN	OUT	IN	OUT					"	1D0-1Q0 1D1-1Q1			"
"	44	**	136						IIN	001	IN	OUT			"	1D1-1Q1 1D2-1Q2			"
и	"	"	137	"									IN	OUT	"	1D3-1Q3			"
"	44	"	138	"											"	2D0-2Q0			"
"	"		139	"											"	2D1-2Q1			"
"	"	"	140												"	2D2-2Q2	"	"	"
"	65	"	141												"	2D3-2Q3		"	u
"	"	"	142	"											"	2D0-2Q0	"		"
"	44	"	143	"											"	2D1-2Q1		"	"
"	44	"	144	"											"	2D2-2Q2			"
u	65	"	145												"	2D3-2Q3		"	"
"	t _{PHL3}	3003	146	IN	IN	GND	5.0 V	OUT	5.0 V		5.0 V		5.0 V		"	1 MR -1Q0	"	25	"
	"	Fig 6-C	147	"						OUT			"		"	1 MR -1Q1		"	"
u	65		148	"								OUT	"		"	1 MR -1Q2		"	"
u	44	"	149	"									"	OUT	"	1 MR -1Q3		"	"
"	"		150	"	GND	IN		OUT							"	1 MR -1Q0	"		"
"			151	"						OUT			"		"	1 MR -1Q1		"	
и	"	"	152	"								OUT			"	1 MR -1Q2	"		"
"	65	"	153	"										OUT	"	1 MR -1Q3		"	"
"	"	"	154												"	2 MR -2Q0		"	"
u	44	"	155												"	2 MR -2Q1	"	"	u
"	"	**	156												"	2 MR -2Q2	"	"	u
"	"	"	157												"	2 MR -2Q3	"	"	ű
u	44	"	158												"	2 MR -2Q0		"	"
u	"	**	159												"	2 MR -2Q1	"	"	u
"	44	"	160												"	2 MR -2Q2		"	"
"	66	"	161												"	2 MR -2Q3	"	"	ű

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Subgroup	Symbol	MIL- STD-883	Case J, K, L, Z	13	14	15	16	17	18	19	20	21	22	23	24	Meas.		Test limit	ts
Subgroup	Symbol	method	Test No.	2 MR	2 Ē 0	2 Ē 1	2D0	2Q0	2D1	2Q1	2D2	2Q2	2D3	2Q3	Vcc	terminal	Min	Max	Unit
9	tPHL2	3003	130	5.0 V											5.0 V	1D0-1Q0	3	28	ns
T _C = 25°C	"	Fig 6	131												"	1D1-1Q1	"		"
"	u		132												"	1D2-1Q2	"		"
"	"		133												"	1D3-1Q3	"		"
"	"		134 135												"	1D0-1Q0 1D1-1Q1			"
"	"	"	135												**	1D1-1Q1 1D2-1Q2			"
"	"	"	137												"	1D3-1Q3			"
"	"	"	138		IN	GND	IN	OUT							"	2D0-2Q0		"	"
u	"	"	139						IN	OUT					"	2D1-2Q1			"
u	"	"	140								IN	OUT			"	2D2-2Q2			"
u	"	"	141										IN	OUT	"	2D3-2Q3			"
u	"	"	142		GND	IN	IN	OUT							"	2D0-2Q0	"	"	u
ш	"	**	143						IN	OUT					"	2D1-2Q1		"	u
ш	"	**	144								IN	OUT			"	2D2-2Q2		"	u
"	u	u	145										IN	OUT	"	2D3-2Q3	"	"	u
"	tPHL3	3003	146												"	1 MR -1Q0	"	25	"
"	"	Fig 6-C	147												"	1 MR -1Q1	"	"	"
и	u		148												"	1 MR -1Q2		"	"
"	"		149												"	1 MR -1Q3	"	"	"
u	u		150												"	1 MR -1Q0			"
и			151												"	1 MR -1Q1		"	
и	u	"	152												"	1 MR -1Q2		"	"
"	u	44	153												**	1 MR -1Q3	"		"
u	"	"	154	IN	IN	GND	5.0 V	OUT	5.0 V		5.0 V		5.0 V		"	2 MR -2Q0	"	"	"
и	u	"	155							OUT					"	2 MR -2Q1			"
ш	"	"	156						"			OUT			"	2 MR -2Q2	"	"	"
ш	"	"	157						"					OUT	"	2 MR -2Q3		"	"
u	"	"	158		GND	IN		OUT					"		"	2 MR -2Q0	"	"	"
u	"	"	159							OUT			"		"	2 MR -2Q1	"	"	"
u	u	"	160						"			OUT	"		**	2 MR -2Q2	"	"	"
u	"	"	161						"				"	OUT	"	2 MR -2Q3	"	"	"

TABLE III. Group A inspection for device type 03. Terminal conditions (pins not designated may be H \ge 2.0 V, or L \le 0.8 V, or open).

Cubaroun	Symbol	MIL- STD-883	Case J, K, L, Z	1	2	3	4	5	6	7	8	9	10	11	12	Meas.		Test limit	s
Subgroup	Symbol	method	Test No.	1 MR	1 Ē 0	1 Ē 1	1D0	1Q0	1D1	1Q1	1D2	1Q2	1D3	1Q3	GND	terminal	Min	Max	Unit
10	tPLH1	3003	162	5.0 V	IN	GND	IN	OUT							GND	1 Ē 0-1Q0	3	60	ns
T _C = 125°C	"	Fig 6-B	163			"			IN	OUT					66	1 Ē 1-1Q1			u
"	u		164								IN	OUT			"	1 Ē 2-1Q2			u
"	"		165										IN	OUT	"	1 Ē 3-1Q3			"
u	u		166		GND	IN	IN	OUT							"	1 Ē 0-1Q0			"
и			167						IN	OUT					66	1 Ē 1-1Q1		"	
"	"	"	168								IN	OUT			"	1 Ē 2-1Q2			"
и	"	"	169										IN	OUT	66	1 E 3-1Q3		"	u
"	"	"	170												"	2 Ē 0-2Q0			u
"	"	"	171												"	2 Ē 1-2Q1			"
и	"	"	172												66	2 Ē 2-2Q2		"	u
"	u	"	173												"	2 Ē 3-2Q3		"	"
"	u	"	174												"	2 Ē 0-2Q0		"	"
"	u	"	175												"	2 Ē 1-2Q1			u
и	u	"	176												"	2 Ē 2-2Q2		"	ű
"	u	"	177												"	2 Ē 3-2Q3			ű

TABLE III. Group A inspection for device type 03. Terminal conditions (pins not designated may be H \geq 2.0 V, or L \leq 0.8 V, or open).

Cubaroup	Cumhal	MIL- STD-883	Case J, K, L, Z	1	2	3	4	5	6	7	8	9	10	11	12	Maga		Test limit	ts
Subgroup	Symbol	method	Test No.	2 MR	2 Ē 0	2 Ē 1	2D0	2Q0	2D1	2Q1	2D2	2Q2	2D3	2Q3	Vcc	Meas. terminal	Min	Max	Unit
10	tPLH1	3003	162	5.0 V											5.0 V	1 E 0-1Q0	3	60	ns
T _C = 125°C	"	Fig 6-B	163												"	1 E 1-1Q1			ű
u	66	"	164												"	1 E 2-1Q2			u
"	66		165												"	1 E 3-1Q3			"
"	66		166												"	1 E 0-1Q0			u
"			167												"	1 E 1-1Q1			
"	"	"	168												"	1 E 2-1Q2			"
u	**	"	169												"	1 E 3-1Q3			"
ű	"	"	170		IN	GND	IN	OUT							"	2 E 0-2Q0			"
ű	"	"	171						IN	OUT					"	2 E 1-2Q1			"
"	66	"	172								IN	OUT			"	2 E 2-2Q2			"
"	66	ű	173										IN	OUT	"	2 E 3-2Q3			u
"	66	"	174		GND	IN	IN	OUT							"	2 E 0-2Q0			u
u	**	ű	175						IN	OUT					"	2 E 1-2Q1			"
"	66	ű	176								IN	OUT			"	2 E 2-2Q2			u
"	"	"	177										IN	OUT	"	2 Ē 3-2Q3			"

TABLE III. Group A inspection for device type 03. Terminal conditions (pins not designated may be H \ge 2.0 V, or L \le 0.8 V, or open).

Subgroup	Symbol	MIL- STD-883	Case J, K, L, Z	1	2	3	4	5	6	7	8	9	10	11	12	Meas.		Test limit	íS
Subgroup	Symbol	method	Test No.	1 MR	1 Ē 0	1 E 1	1D0	1Q0	1D1	1Q1	1D2	1Q2	1D3	1Q3	GND	terminal	Min	Max	Unit
10	tPHL1	3003	178	5.0 V	IN	GND	IN	OUT							GND	1 E 0-1Q0	3	40	ns
T _C = 125°C	"	Fig 6-A	179						IN	OUT					"	1 E 1-1Q1			"
"	"		180								IN	OUT			u	1 E 2-1Q2			"
"	"		181										IN	OUT	u	1 E 3-1Q3			"
"	"		182		GND	IN	IN	OUT							u	1 E 0-1Q0			"
"			183						IN	OUT					u	1 E 1-1Q1			
"	"	"	184								IN	OUT			u	1 E 2-1Q2			"
"	"	"	185										IN	OUT	u	1 E 3-1Q3			"
"	"	"	186												u	2 E 0-2Q0			"
"	"	"	187												u	2 E 1-2Q1			"
"	"	"	188												u	2 E 2-2Q2			"
"	"	"	189												u	2 E 3-2Q3			"
"	"	"	190												u	2 E 0 200			"
"	"	"	191												u	2 E 0-2Q0			**
"	"	"	192												u	2 E 2-2Q2			"
"	"	"	193												u	2 E 2-2Q2			"
	t _{PLH2}	3003	194		IN	GND	IN	OUT							"	1D0-1Q0		49	"
	"	Fig 6	195						IN	OUT					"	1D1-1Q1			**
"	"		196								IN	OUT			"	1D2-1Q2			"
"	"		197										IN	OUT	u	1D3-1Q3			"
"	"		198		GND	IN	IN	OUT							u	1D0-1Q0			"
u	"	"	199						IN	OUT					"	1D1-1Q1			"
		"	200								IN	OUT			"	1D2-1Q2 1D3-1Q3			"
	"	"	201										IN	OUT	"	2D0-2Q0			
"	"	"	202												"	2D0-2Q0 2D1-2Q1			"
"		"	203												"	2D2-2Q2			"
•	"		204													2D2-2Q2 2D3-2Q3			
"	"	"	205												"				"
"	"	"	206												"	2D0-2Q0 2D1-2Q1			
"	ű	"	207															"	"
"	"	"	208												"	2D2-2Q2			"
"	"	ű	209												u	2D3-2Q3	-		"

TABLE III. Group A inspection for device type 03. Terminal conditions (pins not designated may be H \geq 2.0 V, or L \leq 0.8 V, or open).

Subgroup	Symbol	MIL- STD-883	Case J, K, L, Z	13	14	15	16	17	18	19	20	21	22	23	24	Meas.		Test limit	.S
Subgroup	Symbol	method	Test No.	2 MR	2 Ē 0	2 Ē 1	2D0	2Q0	2D1	2Q1	2D2	2Q2	2D3	2Q3	Vcc	terminal	Min	Max	Unit
10	tPHL1	3003	178	5.0 V											5.0 V	1 E 0-1Q0	3	40	ns
T _C = 125°C	"	Fig 6-A	179												"	1 E 1-1Q1			"
"	"		180												"	1 E 2-1Q2			"
"	"		181												u	1 E 3-1Q3			"
"	"		182												"	1 E 0-1Q0			"
"			183												u	1 E 1-1Q1			
"	"	"	184												"	1 E 2-1Q2			**
u	"	"	185												u	1 E 3-1Q3			"
"	"	"	186		IN	GND	IN	OUT							u	2 E 0-2Q0			"
"	"	"	187						IN	OUT					"	2 E 0 2Q0			**
u	"	"	188								IN	OUT			u	2 E 2-2Q2			"
"	"	"	189										IN	OUT	u	2 E 3-2Q3			"
"	"	"	190		GND	IN	IN	OUT							u	2 E 0 2Q0			"
"	"	"	191						IN	OUT					u	2 E 0-2Q0 2 E 1-2Q1			"
"	"	"	192								IN	OUT			"	2 E 2-2Q2			"
"	"	"	193										IN	OUT	u	2 E 3-2Q2			"
	t _{PLH2}	3003	194													1D0-1Q0		49	
	"FLHZ	Fig 6	195												"	1D1-1Q1			"
"	"		196												"	1D2-1Q2			"
"	"		197												u	1D3-1Q3			"
"	"		198												"	1D0-1Q0			**
"	"		199												u	1D1-1Q1			"
"	"	"	200												"	1D2-1Q2			"
"			201													1D3-1Q3			
"	"	"	202		IN	GND	IN	OUT							"	2D0-2Q0			**
"	"	"	203						IN	OUT					"	2D1-2Q1			**
"	"	"	204	"	"						IN	OUT			u	2D2-2Q2			"
ű	"	"	205	"									IN	OUT	u	2D3-2Q3			"
ű	"	"	206		GND	IN	IN	OUT							u	2D0-2Q0			"
ű	"	"	207						IN	OUT					u	2D1-2Q1			"
"	"	"	208								IN	OUT			u	2D2-2Q2			"
"	"	"	209										IN	OUT	"	2D3-2Q3			"

TABLE III. Group A inspection for device type 03. Terminal conditions (pins not designated may be H \geq 2.0 V, or L \leq 0.8 V, or open).

Out	Ourseland	MIL- STD-883	Case J, K, L, Z	1	2	3	4	5	6	7	8	9	10	11	12			Test limit	ts
Subgroup	Symbol	method	Test No.	1 MR	1 Ē 0	1 Ē 1	1D0	1Q0	1D1	1Q1	1D2	1Q2	1D3	1Q3	GND	Meas. terminal	Min	Max	Unit
10	tPHL2	3003	210	5.0 V	IN	GND	IN	OUT							GND	1D0-1Q0	3	37	ns
T _C = 125°C	u	Fig 6	211						IN	OUT					"	1D1-1Q1			u
"	u		212								IN	OUT			"	1D2-1Q2			"
u	и	"	213										IN	OUT	"	1D3-1Q3	"		"
"	"		214 215		GND "	IN "	IN	OUT	IN	OUT					"	1D0-1Q0 1D1-1Q1			
"	"	"	215						IIN	001	IN	OUT			"	1D1-1Q1 1D2-1Q2			"
"	u	u	217										IN	OUT	"	1D3-1Q3			"
"	"	"	218												"	2D0-2Q0			"
u	и	u	219												"	2D1-2Q1			u
u	"	u	220												"	2D2-2Q2			"
u	"	u	221												"	2D3-2Q3			"
"	"	"	222												"	2D0-2Q0			"
"	u	"	223												"	2D1-2Q1			"
"	"	"	224												"	2D2-2Q2			"
u	и	u	225												"	2D3-2Q3			u
"	t _{PHL3}	3003	226	IN	IN	GND	5.0 V	OUT	5.0 V		5.0 V		5.0 V			1 MR -1Q0			"
	"	Fig 6-C	227							OUT					"	1 MR -1Q1			"
"	"		228									OUT			"	1 MR -1Q2			"
"	u		229											OUT	"	1 MR -1Q3			u
"	u		230		GND	IN		OUT							"	1 MR -1Q0			u
"			231							OUT					"	1 MR -1Q1			
"	u	u	232									OUT			"	1 MR -1Q2			u
"	"	"	233											OUT	"	1 MR -1Q3			"
"	"	"	234												"	2 MR -2Q0			"
"	u	u	235												"	2 MR -2Q1			u
u	"	u	236												"	2 MR -2Q2			"
"	"	"	237												"	2 MR -2Q3			"
"	"	"	238												"	2 MR -2Q0			"
"	"	"	239												"	2 MR -2Q1			"
u	и	u	240												"	2 MR -2Q2			u
"	u	u	241												"	2 MR -2Q3			"
11	Same tests	s, terminal con	ditions and limits a	as for subg	group 10, e	except T _C	= -55°C.												

TABLE III. Group A inspection for device type 03. Terminal conditions (pins not designated may be H \ge 2.0 V, or L \le 0.8 V, or open).

Cubarour	Cumhal	MIL- STD-883	Case J, K, L, Z	13	14	15	16	17	18	19	20	21	22	23	24	Maga		Test limit	:S
Subgroup	Symbol	method	Test No.	$2 \overline{MR}$	2 Ē 0	2 Ē 1	2D0	2Q0	2D1	2Q1	2D2	2Q2	2D3	2Q3	Vcc	Meas. terminal	Min	Max	Unit
10	t _{PHL2}	3003	210	5.0 V											5.0 V	1D0-1Q0	3	37	ns
T _C = 125°C	"	Fig 6	211												"	1D1-1Q1			"
"	"		212												"	1D2-1Q2			"
ű	"		213												"	1D3-1Q3			"
"	"		214 215												"	1D0-1Q0 1D1-1Q1			"
ű	"	"	215												"	1D1-1Q1 1D2-1Q2			"
"	"	"	217												"	1D3-1Q3			"
ű	"	"	218		IN	GND	IN	OUT							"	2D0-2Q0			"
"	"	"	219						IN	OUT					"	2D1-2Q1			"
ű	"	"	220								IN	OUT			"	2D2-2Q2			"
ű	"	"	221										IN	OUT	"	2D3-2Q3			"
ű	**	"	222		GND	IN	IN	OUT							"	2D0-2Q0			"
"	"	"	223						IN	OUT					"	2D1-2Q1			**
"	**	"	224								IN	OUT			"	2D2-2Q2			"
ű	"	u	225		•								IN	OUT	"	2D3-2Q3			"
	tPHL3	3003	226													1 MR -1Q0			
•	**	Fig 6-C	227												"	1 MR -1Q1			"
ű	**		228												"	1 MR -1Q2			**
ű	"		229												"	1 MR -1Q3			"
ű	"		230												"	1 MR -1Q0			"
"			231												"	1 MR -1Q1			
"	"	"	232												"	1 MR -1Q2	"		"
"	**	"	233												"	1 MR -1Q3			"
ű	**	"	234	IN	IN	GND	5.0 V	OUT	5.0 V		5.0 V		5.0 V		"	2 MR -2Q0			**
ű	**	"	235							OUT					"	2 MR -2Q1			**
"	"	"	236			"			"			OUT	"		"	2 MR -2Q2			**
"	"	"	237											OUT	"	2 MR -2Q3			**
"	**	"	238		GND	IN		OUT					"		"	2 MR -2Q0			"
ű	"	"	239			"			"	OUT	"				"	2 MR -2Q1	"		"
"	"	"	240									OUT			"	2 MR -2Q2			"
"	"	u	241	"	"	"			"		"			OUT	"	2 MR -2Q3			"
11	Same tests	s, terminal con	ditions and limits a	as for subo	group 10, e	except T _C	= -55°C.												

TABLE III. Group A inspection for device type 03. Terminal conditions (pins not designated may be H \ge 2.0 V, or L \le 0.8 V, or open).

		MIL-	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16			Test limits	
Subgroup	Symbol	STD-883 method	Test No.	Ē	s o	D0	D1	<u></u> <u></u> <u></u> S 2	D2	D3	GND	MR	Q3	<u></u> 5 3	Q2	Q1		Q0	V _{cc}	Meas. terminal	Min	Max	Unit
1	VOH	3006	1	0.8 V	0.8 V	2.0 V	2.0 V	0.8 V	2.0 V	2.0 V	GND	2.0 V		0.8 V			0.8 V	-800µA	4.5 V	Q0	2.4		V
T _C = 25°C	"	"	2													-800µA				Q1			"
"	"	"	3												-800µA					Q2			"
"	"	"	4										-800µA							Q3			"
"	V _{OL}	3007	5	"		0.8 V	0.8 V	"	0.8 V	0.8 V	"	"		"				16 mA		Q0		0.4	"
39			6													16 mA				Q1			"
"			7												16 mA					Q2			"
**	"	"	8										16 mA							Q3			"
"	VIC		9	-12 mA							"									Ē		-1.5	ű
"			10		-12 mA															s o			"
"			11			-12 mA														D0			"
u	"		12				-12 mA													D1			"
"			13					-12 mA												<u>s</u> 2			
"			14						-12 mA											D2			
u			15							-12 mA										D3			
			16									-12 mA								MR			
"	"		17											-12 mA						<u></u> S 3			"
			18														-12 mA			S 1			
"	lıL1	3009	19	GND	GND	0.4 V		GND			"			GND			GND		5.5 V	D0	-0.7	-2.7	mA
			20				0.4 V													D1			
"			21						0.4 V											D2			"
			22							0.4 V										D3			
"	I _{IL2}	"	23	0.4 V																Ē		-1.6	"
			24		0.4 V															<u></u> <u>s</u> 0			
u			25					0.4 V												<u>s</u> 2			
			26									0.4 V								MR			
u			27											0.4 V						<u>s</u> 3			
u		"	28														0.4 V			5 1	"		
u	liH1	3010	29	5.5 V	5.5 V	2.4 V		5.5 V			"	GND		5.5 V			5.5 V		"	D0		80	μA
"	"	"	30				2.4 V													D1			"
"			31						2.4 V					"						D2			"
u	u	"	32							2.4 V										D3			"

TABLE III. Group A inspection for device type 04. Terminal conditions (pins not designated may be $H \ge 2.0$ V or $L \le 0.8$ V or open).

		MIL-	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16			Test limits	i
Subgroup	Symbol	STD-883 method	Test No.	Ē	Ξ0	D0	D1	<u></u> <u></u> <u></u> S 2	D2	D3	GND	MR	Q3	<u></u> 5 3	Q2	Q1		Q0	V _{CC}	Meas. terminal	Min	Max	Unit
1	I _{IH2}	3010	33	5.5 V	5.5 V	5.5 V		5.5 V			GND	GND		5.5 V			5.5 V		5.5 V	D0		200	μA
T _C = 25°C	"	"	34				5.5 V	•												D1			"
"			35						5.5 V											D2			"
"	u	u	36							5.5 V										D3			"
	I _{IH3}	3006	37	2.4 V																Ē		40	
	"	u	38		2.4 V															<u></u> <u>s</u> 0			"
"	"	"	39					2.4 V												<u>s</u> 2			"
"	"	"	40									2.4 V								MR			"
"			41											2.4 V						<u>s</u> 3			"
33			42														2.4 V			S 1			"
"	I _{IH4}	"	43	5.5 V																Ē		100	ű
26	u	"	44		5.5 V															<u></u> <u>s</u> 0			"
"			45					5.5 V												<u>s</u> 2			"
"			46									5.5 V								MR			"
"			47											5.5 V						<u>s</u> 3			"
"	u		48														5.5 V			<u></u> S 1			"
"	los	3011	49	GND	GND	4.5 V					"	5.5 V						GND		Q0	-20	-100	mA
"			50				4.5 V									GND	GND			Q1			
"			51					GND	4.5 V						GND					Q2			•
			52							4.5 V			GND	GND						Q3			
"	Icc	3005	53	4.5 V	GND			GND				GND		GND			GND		"	V _{CC}		55	"
2	Same tests	, terminal con	ditions and limits	as for sub	ogroup 1, e	xcept T _C =	= 125°C ai	nd V _{IC} tests	s are omitt	ed.	•				•	•	•			•			
3	Same tests	, terminal con	ditions and limits	as for sub	group 1, e	xcept T _C =	-55°C an	d V _{IC} tests	are omitte	d.													
9	t _{PLH1}	3003	54	IN	GND	IN					GND	5.0 V						OUT	5.0 V	Ē -Q0	9	30	ns
T _C = 25°C		Fig 7-A	55				IN									OUT	GND		"	Ē -Q1	"		"
"			56					GND	IN						OUT				"	Ē -Q2			•
"			57	"						IN	"		OUT	GND					"	Ē -Q3	-	-	"
"	t _{PHL1}	3003	58	IN	GND	IN												OUT	"	Ē -Q0		29	ns
"		Fig 7-B	59				IN				"					OUT	GND		"	Ē -Q1	"	"	"
"			60					GND	IN		"				OUT				"	Ē-Q2	"	"	
"			61							IN			OUT	GND						Ē -Q3			"

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TABLE III. Group A inspection for device type 04. Terminal conditions (pins not designated may be H \ge 2.0 V or L \le 0.8 V or open).

		MIL-	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16			Test limits	
Subgroup	Symbol	STD-883 method	Test No.	Ē	Ξ 0	D0	D1		D2	D3	GND	MR	Q3	<u></u> 5 3	Q2	Q1	S 1	Q0	V _{CC}	Meas. terminal	Min	Max	Unit
9	tPHL1	3003	62	IN	GND	IN					GND	5.0 V						OUT	5.0 V	Ē -Q0	9	29	ns
T _C = 25°C		Fig 7-C	63				IN									OUT	GND			Ē -Q1			"
			64					GND	IN						OUT					Ē -Q2			
"			65							IN			OUT	GND						Ē -Q3			"
	t _{PLH2}	3003	66		GND	IN												OUT		D0-Q0	=	21	ns
		Fig 7-B	67				IN									OUT	GND			D1-Q1			"
			68					GND	IN						OUT					D2-Q2			
"			69							IN			OUT	GND						D3-Q3			"
	t _{PLH2}	3003	70		GND	IN												OUT		D0-Q0			
		Fig 7-C	71				IN									OUT	GND			D1-Q1			"
			72					GND	IN						OUT					D2-Q2			
"			73							IN			OUT	GND						D3-Q3			"
	t _{PLH2}	3003	74	GND	GND	IN												OUT		D0-Q0	"		
		Fig 7-D	75				IN									OUT	GND			D1-Q1		•	"
			76					GND	IN						OUT					D2-Q2		•	
"			77							IN			OUT	GND						D3-Q3			"
	t _{PHL2}	3003	78		GND	IN												OUT		D0-Q0	3	30	"
		Fig 7-E	79				IN									OUT	GND			D1-Q1			"
			80					GND	IN						OUT					D2-Q2			
"			81							IN			OUT	GND						D3-Q3			"
	t _{PHL2}	3003	82	IN	GND	IN												OUT		D0-Q0	"		
		Fig 7-A	83				IN									OUT	GND			D1-Q1			"
•			84					GND	IN						OUT					D2-Q2		•	
"			85							IN			OUT	GND						D3-Q3			"
	t _{PHL3}	3003	86		GND	5.0 V						IN						OUT		MR -Q0	9	23	
		Fig 7-F	87				5.0 V									OUT	GND			MR -Q1			**
			88					GND	5.0 V						OUT					MR -Q2		•	
ű			89							5.0 V	•		OUT	GND						MR -Q3			"
	t _{PLH4}	3003	90	GND	IN	IN					"	5.0 V						OUT			"	29	
		Fig 7-E	91				IN									OUT	IN						"
			92					IN	IN						OUT								
"			93							IN			OUT	IN						S 3-Q3			**

TABLE III. Group A inspection for device type 04. Terminal conditions (pins not designated may be H \ge 2.0 V or L \le 0.8 V or open).

		MIL-	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16			Test limits	;
Subgroup	Symbol	STD-883 method	Test No.	Ē	s o	D0	D1	<u></u> <u></u> <u></u> S 2	D2	D3	GND	MR	Q3		Q2	Q1		Q0	V _{CC}	Meas. terminal	Min	Max	Unit
10	t _{PLH1}	3003	94	IN	GND	IN					GND	5.0 V						OUT	5.0 V	Ē -Q0	9	47	ns
T _C = 125°C		Fig 7-A	95				IN									OUT	GND			Ē -Q1			u
			96					GND	IN						OUT					Ē -Q2			
"			97							IN			OUT	GND						Ē -Q3			"
	tPHL1	3003	98		GND	IN					"							OUT		Ē -Q0		33	ns
		Fig 7-B	99				IN									OUT	GND			Ē -Q1			u
			100					GND	IN						OUT					Ē -Q2			
"			101							IN			OUT	GND						 E -Q3			"
	t _{PHL1}	3003	102		GND	IN					"	"						OUT		 E -Q0			ns
		Fig 7-C	103				IN									OUT	GND			 E -Q1			"
			104					GND	IN						OUT					Ē -Q2			
"			105							IN			OUT	GND						Ē -Q3			"
	t _{PLH2}	3003	106		GND	IN					"							OUT		D0-Q0		37	ns
		Fig 7-B	107				IN									OUT	GND			D1-Q1			u
			108					GND	IN						OUT					D2-Q2			
"			109							IN			OUT	GND						D3-Q3			"
	tPLH2	3003	110		GND	IN					"	"						OUT		D0-Q0			"
		Fig 7-C	111				IN									OUT	GND			D1-Q1			u
			112					GND	IN						OUT					D2-Q2			
"			113							IN			OUT	GND						D3-Q3			"
	t _{PLH2}	3003	114	GND	GND	IN					"	"						OUT		D0-Q0			"
		Fig 7-D	115				IN									OUT	GND			D1-Q1			u
			116					GND	IN						OUT					D2-Q2			
"			117							IN			OUT	GND						D3-Q3			u
	t _{PHL2}	3003	118		GND	IN					"	"						OUT		D0-Q0	3		"
		Fig 7-E	119				IN									OUT	GND			D1-Q1			"
			120					GND	IN						OUT					D2-Q2			
"			121							IN			OUT	GND						D3-Q3			"
	tPHL2	3003	122	IN	GND	IN					"							OUT		D0-Q0			"
		Fig 7-A	123				IN									OUT	GND			D1-Q1			u
			124					GND	IN						OUT					D2-Q2			
u			125	"						IN			OUT	GND						D3-Q3			u

TABLE III. Group A inspection for device type 04. Terminal conditions (pins not designated may be $H \ge 2.0$ V or L ≤ 0.8 V or open).

		MIL-	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16			Test limits	6
Subgroup	Symbol	STD-883 method	Test No.	Ē	s o	D0	D1	S 2	D2	D3	GND	MR	Q3	<u></u> 	Q2	Q1	S 1	Q0	V _{CC}	Meas. terminal	Min	Max	Unit
10	t _{PHL3}	3003	126	IN	GND	5.0 V					GND	IN						OUT	5.0 V	MR -Q0	9	30	ns
T _C = 125°C		Fig 7-F	127				5.0 V									OUT	GND			MR -Q1			"
		"	128					GND	5.0 V						OUT					MR -Q2			
"	"	"	129							5.0 V			OUT	GND						MR -Q3			"
"	tPLH4	3003	130	GND	IN	IN					"	5.0 V						OUT		S 0-Q0	"	47	
"		Fig 7-E	131				IN									OUT	IN			S 1-Q1			"
			132					IN	IN						OUT					s 2-Q2			
u			133							IN	"	"	OUT	IN					"	5 3-Q3			u
11	Same tests, terminal conditions and limits as subgroup 10, except $T_c = -55^{\circ}C$.																						

TABLE III. Group A inspection for device type 04. Terminal conditions (pins not designated may be $H \ge 2.0$ V or $L \le 0.8$ V or open).

5. PACKAGING

5.1 <u>Packaging requirements.</u> For acquisition purposes, the packaging requirements shall be as specified in the contract or order (see 6.2). When packaging of materiel is to be performed by DoD or in-house contractor personnel, these personnel need to contact the responsible packaging activity to ascertain packaging requirements. Packaging requirements are maintained by the Inventory Control Point's packaging activity within the Military Service or Defense Agency, or within the military service's system command. Packaging data retrieval is available from the managing Military Department's or Defense Agency's automated packaging files, CD-ROM products, or by contacting the responsible packaging activity.

6. NOTES

(This section contains information of a general or explanatory nature that may be helpful, but it is not mandatory)

6.1 <u>Intended use.</u> Microcircuits conforming to this specification are intended for logistic support of existing equipment.

- 6.2 <u>Acquisition requirements.</u> Acquisition documents should specify the following:
 - a. Title, number, and date of the specification.
 - b. PIN and compliance identifier, if applicable (see 1.2).
 - c. Requirements for delivery of one copy of the conformance inspection data pertinent to the device inspection lot to be supplied with each shipment by the device manufacturer, if applicable.
 - d. Requirement for certificate of compliance, if applicable.
 - e. Requirements for notification of change of product or process to acquiring activity in addition to notification to the qualifying activity, if applicable.
 - f. Requirements for failure analysis (including required test condition of method 5003), corrective action and reporting of results, if applicable.
 - g. Requirements for product assurance options.
 - h. Requirements for carriers, special lead lengths or lead forming, if applicable. These requirements shall not affect the part number. Unless otherwise specified, these requirements will not apply to direct purchase by or direct shipment to the Government.
 - i. Requirements for "JAN" marking.
 - j. Packaging requirements (see 5.1).

6.3 <u>Qualification</u>. With respect to products requiring qualification, awards will be made only for products which are, at the time of award of contract, qualified for inclusion in Qualified Manufacturers List QML-38535 whether or not such products have actually been so listed by that date. The attention of the contractors is called to these requirements, and manufacturers are urged to arrange to have the products that they propose to offer to the Federal Government tested for qualification in order that they may be eligible to be awarded contracts or purchase orders for the products covered by this specification. Information pertaining to qualification of products may be obtained from DSCC-VQ, 3990 E. Broad Street, Columbus, Ohio 43123-1199.

6.4 <u>Superseding information</u>. The requirements of MIL-M-38510 have been superseded to take advantage of the available Qualified Manufacturer Listing (QML) system provided by MIL-PRF-38535. Previous references to MIL-M-38510 in this document have been replaced by appropriate references to MIL-PRF-38535. All technical requirements now consist of this specification and MIL-PRF-38535. The MIL-M-38510 specification sheet number and PIN have been retained to avoid adversely impacting existing government logistics systems and contractor's parts lists.

6.5 <u>Abbreviations, symbols and definitions.</u> The abbreviations, symbols, and definitions used herein are defined in MIL-PRF-38535 and MIL-HDBK-1331, and as follows:

GND Electrical ground (common terminal) V_{IN} Voltage level at an input terminal

6.6 <u>Logistic support.</u> Lead materials and finishes (see 3.3) are interchangeable. Unless otherwise specified, microcircuits acquired for Government logistic support will be acquired to device class B (see 1.2.2), lead material and finish A (see 3.4). Longer lead lengths and lead forming shall not affect the part number.

6.7 <u>Substitutability.</u> The cross-reference information below is presented for the convenience of users. Microcircuits covered by this specification will functionally replace the listed generic-industry type. Generic-industry microcircuit types may not have equivalent operational performance characteristics across military temperature ranges or reliability factors equivalent to MIL-M-35810 device types and may have slight physical variations in relation to case size. The presence of this information should not be deemed as permitting substitution of generic-industry types for MIL-M-38510 types or as a waiver of any of the provisions of MIL-PRF-38535.

Device type	Commercial type
01	5475, 7475 (circuit A)
01	SN5475, SN7475 (circuit B)
02	5477, 7477 (circuit A)
02	SN5477, SN7477 (circuit B)
03	9308 (circuit A)
03	54116, 74116 and SN74116 (circuit B)
03	S54116 (circuit C)
04	9314 (circuit A)
04	AM9314 (circuit B)

6.8 <u>Changes from previous issue.</u> Marginal notations are not used in this revision to identify changes with respect to the previous issue due to the extensiveness of the changes.

Custodians: Army - CR Navy - EC Air Force - 11 DLA - CC Preparing activity: DLA - CC

(Project 5962-2104)

Review activities: Army - MI, SM Navy - AS, CG, MC, SH, TD Air Force - 03, 19, 99

NOTE: The activities listed above were interested in this document as of the date of this document. Since organizations and responsibilities can change, you should verify the currency of the information above using the ASSIST Online database at http://assist.daps.dla.mil.